

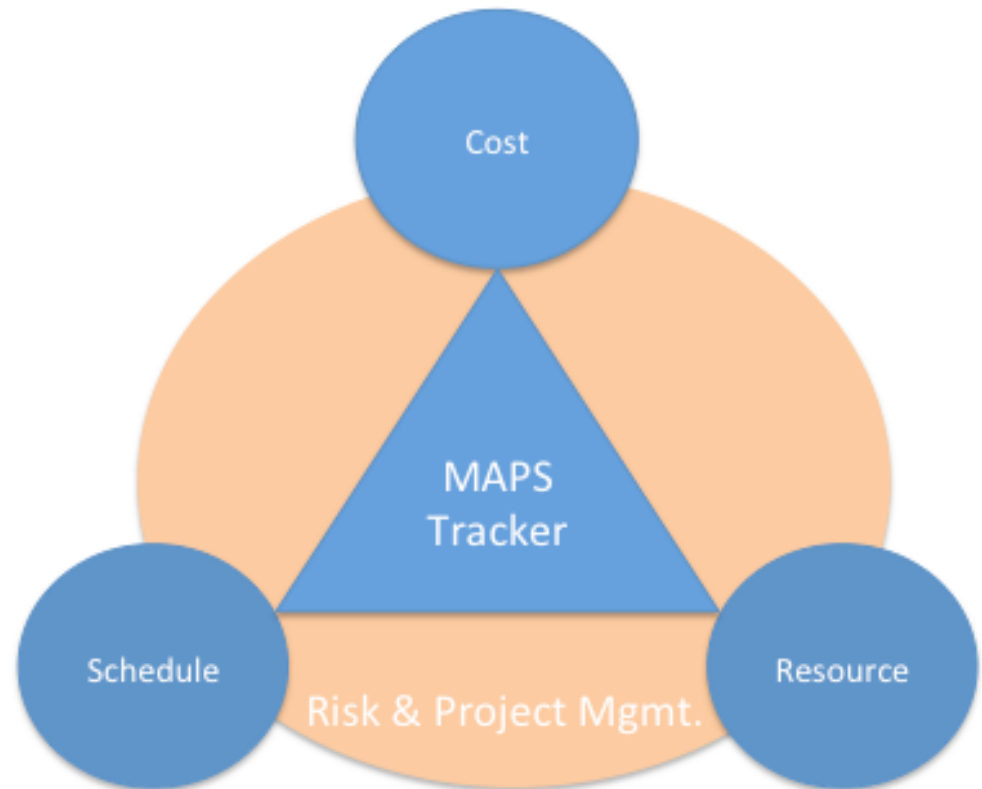
MAPS Cost, Schedule and Resources Plan

Ming Liu

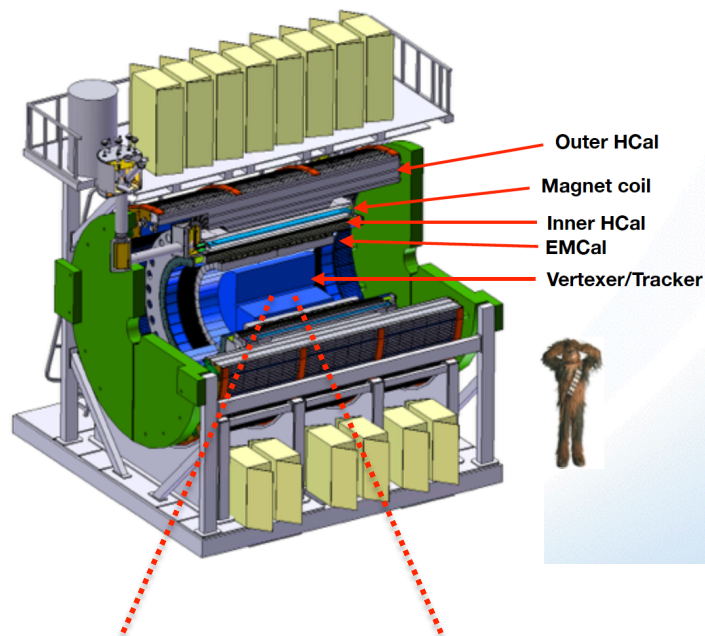
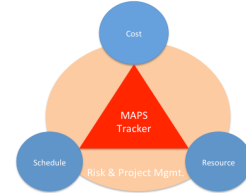
Los Alamos National Laboratory

Outline

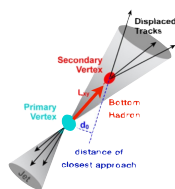
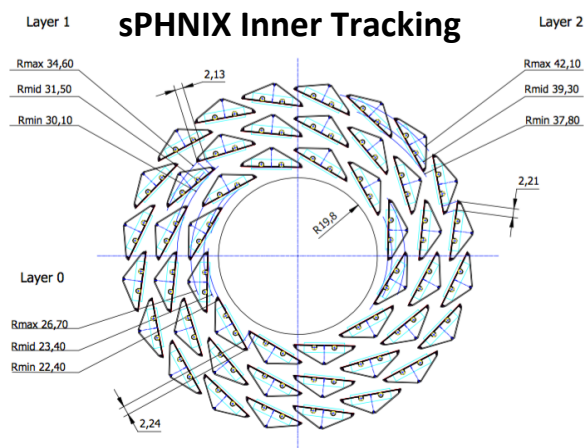
- Scope of Project
 - MAPS inner tracker
 - Cost and Schedule Basis
- Cost
 - R&D
 - Production
- Schedule
 - R&D
 - Production
- Resources
- Risk and project management



sPHENIX MAPS Inner Tracker

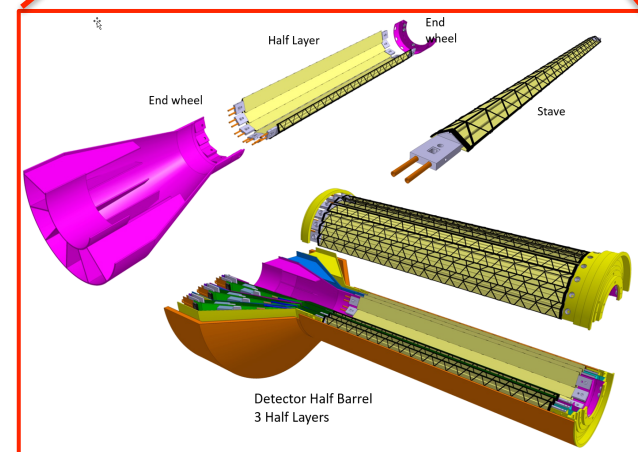
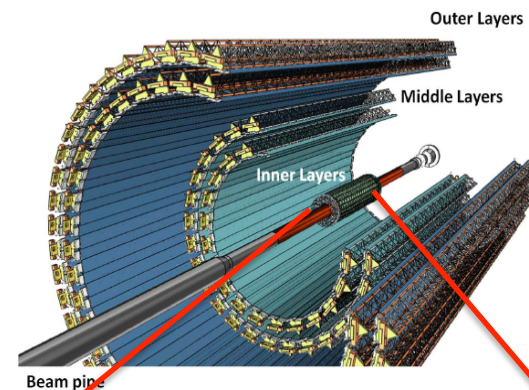


Key issues:
Integration of
Readout &
Mechanics

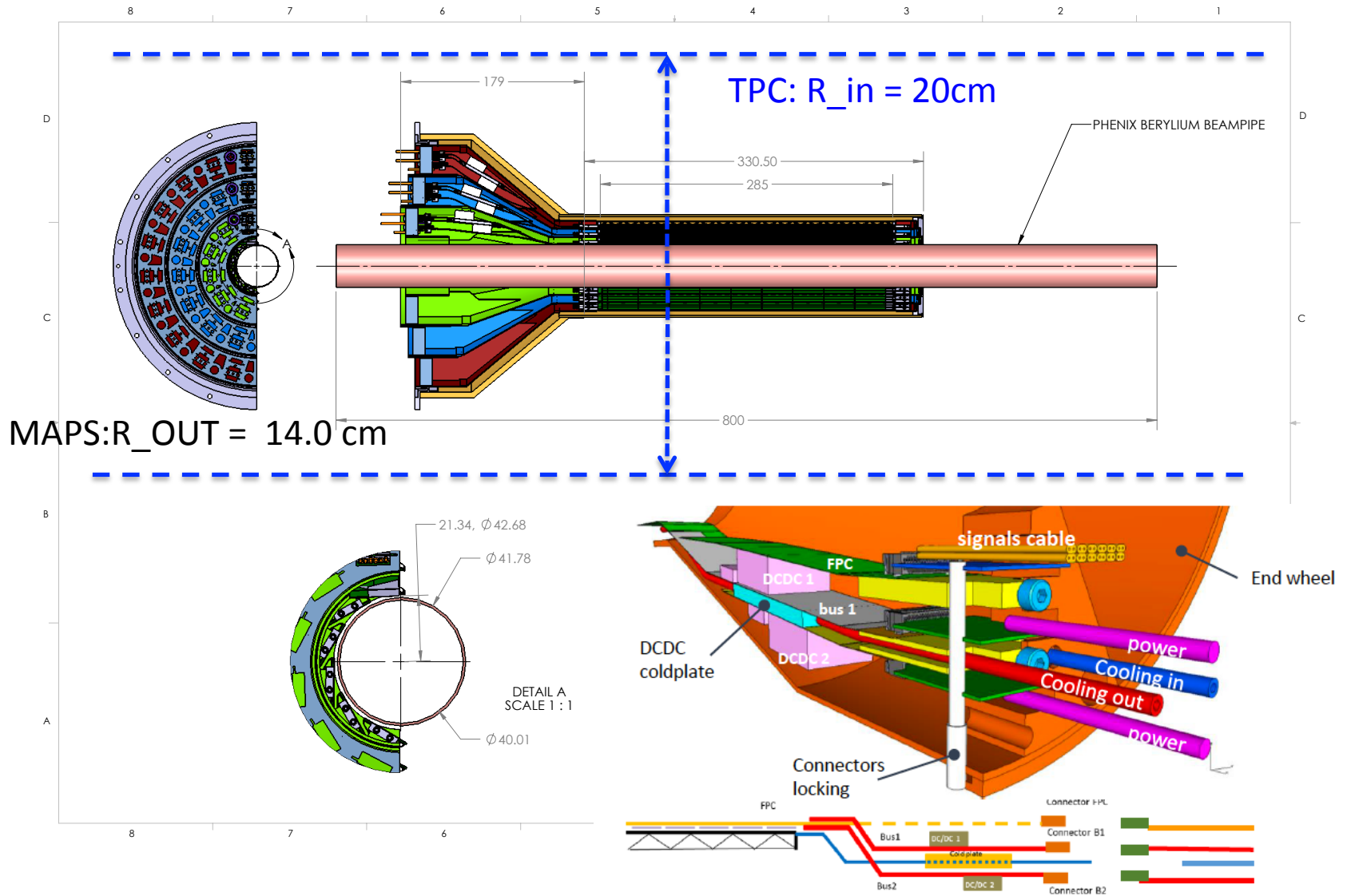
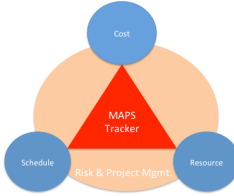


Copy of ITS
Inner Tracker

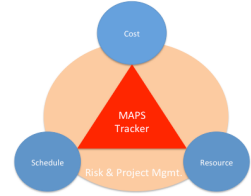
ALICE ITS;
Inner Tracker System



sPHENIX MAPS Inner Tracker



Scope of the Project

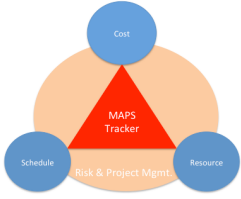


- **MAPS & Electronics**

- MAPS Detectors
 - MoU to build 68 ITS MAPS staves
 - No modification
- Readout Electronics
 - Use ALICE/ITS, RDO + CRU
 - Modify/reprogram CRU for sPHENIX
 - Plan-B: build a custom board to convert ALICE/ITS into sPHENIX DAQ format
 - R&D by LANL LDRD
- Production
 - Extend ALICE/ITS MAPS stave production
 - Train sPHENIX personnel for assembly and testing staves at CERN
 - Reproduce additional ALICE RDO+CRU for sPHENIX
- Ancillary systems
 - LV, cables, crates, racks etc.
 - Slow control, safety and monitoring

- **Mechanics & Cooling**

- No/minor changes to ALICE/ITS inner tracker mechanical structures
 - End Wheels
 - Cylindrical structure shells
 - Detector half barrels
 - Service half barrels
 - Detector and Service half barrels
 - Half support structures
- Mechanics Integration into sPHENIX system
 - Conceptual design by LANL LDRD
 - Prototype by BNL sPHENIX R&D
 - Design integration frames
 - Cage
 - Installation tooling etc.
- ALICE cooling plant
 - Minor modification to fit sPHENIX
 - Smaller heat load than ALICE ITS
- Metrology and Survey

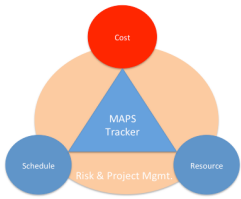


Assumptions

- Copy ALICE 3-layer MAPS Inner Tracker
 - Extend ALICE ITS production
 - Follow proposed sPHENIX CD process
 - Critical R&D for CD-1 and CD-2/3 by LANL LDRD
 - Mechanical Integration R&D fund available for CD-2/3
 - Production starts at CD-3b
-
- Initial cost and schedule from ALICE ITS documents
 - Other cost from recent experiments, FVTX/PHENIX, HFT/STAR
 - Manpower costs from Lab Engineers and Techs
 - Durations from ALICE C&S where available, FVTX/PHENIX experience
 - Schedule contingency in progress (MoU w/ ALICE, mortgage etc.)
 - Apply 30% cost & schedule contingency (prorated from ITS C&S)
 - Initial cost and manpower allocation, w/o funding profile

MAPS Cost and Schedule Workshop

3/30-4/1, 2016, Santa Fe, NM



<https://indico.bnl.gov/conferenceDisplay.py?confId=1741>

Well attended by experts from:
sPHENIX, ITS/ALICE,
HFT/STAR, FVTX/PHENIX, EIC

LANL, CERN, LBNL, BNL, MIT, FSU, UColorado
Yonsei/Korea, and several other US institutions

Take Home:

- Extension of ALICE production possible
- Inner tracker cost <\$5M inc. contingency
- Can meet sPHENIX CD schedule



8/30/16

sPHENIX MAPS Cost & Schedule Workfest

from 30 March 2016 to 01 April 2016 (US/Mountain) *El Dorado Hotel*
US/Mountain timezone

Overview

Timetable

Contribution List

Author Index

Registration

Registration Form

List of registrants

The purpose of this 3 day workfest is to define and document the cost and schedule for the MAPS based tracking options under consideration for the sPHENIX detector. The interactive workfest format will be organized into topical breakout teams with MAPS, engineering, and C&S experts we are gathering from ALICE, sPHENIX, and other projects and will minimize time spent in presentations.

Update 3/2/16: The workfest will be held at the El Dorado Hotel. The hotel is located just a short walk west of the historic downtown square. See <http://www.eldoradohotel.com> for more hotel details. We've arranged for a block of rooms is available now and can be booked at the workfest/gov't rate (\$99/night) if you follow: [https://gc.synxis.com/rez.aspx?Hotel=63150&Chain=17123&Dest=Santa Fe &template=GCF&shell=GCF&locale=en-US&arrive=3/29/2016&depart=4/1/2016&adult=1&child=0&group=sPHENIX](https://gc.synxis.com/rez.aspx?Hotel=63150&Chain=17123&Dest=Santa%20Fe&template=GCF&shell=GCF&locale=en-US&arrive=3/29/2016&depart=4/1/2016&adult=1&child=0&group=sPHENIX) which will lead you to a web form for the conference. If you decide to call the hotel directly at 505-995-4500, our call-in/group code for the reservations is: sPHENIX.

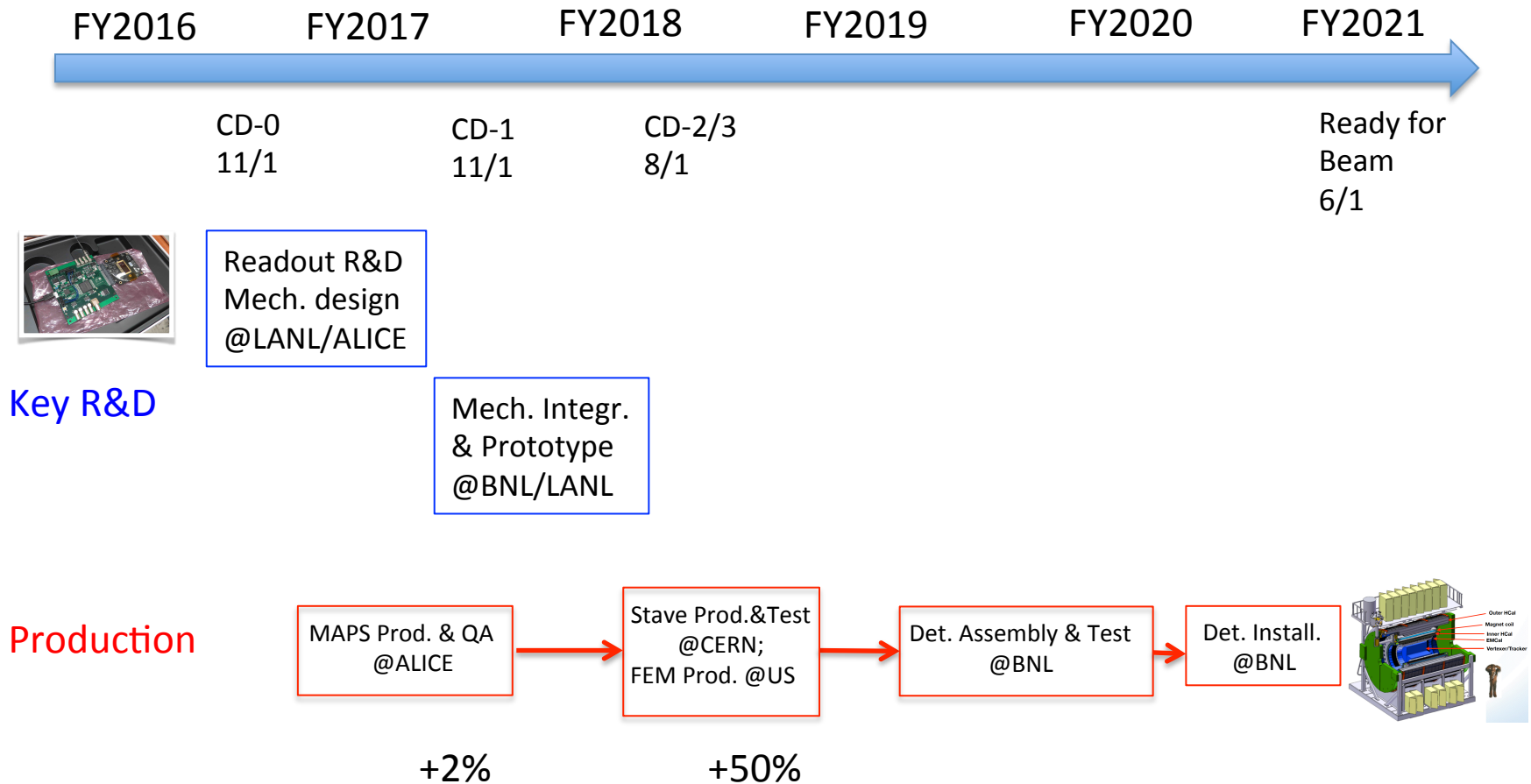
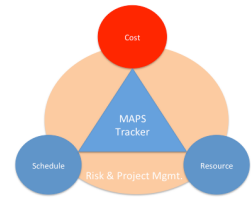
FAQ: *Should I fly out of ABQ on Friday evening or Saturday morning?*

The answer to this is if you can find a suitable flight or not. We expect that some participants will book flights out Friday evening and leave the workfest in the afternoon to take those flights. Not all participants will find a flight and so Saturday morning will be an option for them. Our plan is to be finalizing the C&S document on Friday afternoon. The organizers will stay until the end of the day and go to dinner with the remaining participants. The drive from Santa Fe to the airport (ABQ) will take approximately 1 hour.

Dates: from 30 March 2016 09:00 to 01 April 2016 17:30
Timezone: US/Mountain
Location: *El Dorado Hotel*
309 W San Francisco St.
Santa Fe, NM 87501
Room: DeVargas
Material: [Folder](#)
[Slides](#)

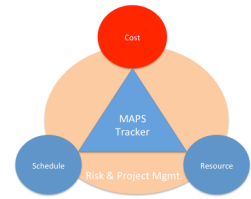
- First draft Cost and Schedule project was produced based on inputs from Santa Fe Workshop
- Further inputs from BNL 6/30 MAPS mini review

Project Task and Time Line



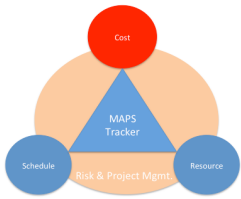
MoU w/ ALICE: 12/2016
To produce staves, frames and FEMs

Major Item Cost Estimate w/ Contingency



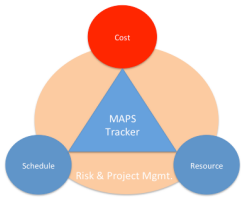
SPHENIX MAPS Inner Tracker Cost Estimate						
3 MAPS layers	Updated: 8/27/2016					
FY16 dollars						
						Funding Profile
	R&D	R&D	Production (k\$)	Comments	Total Contingency	Cost with Contingency (k\$)
	LANL (k\$)	BNL (k\$)				FY17-FY21
MAPS Staves	128		1064	Alice production	0.3	1383.2
						0
RDO boards	7.4		354	Alice production	0.3	460.2
CRU boards	11		183.3	Alice production	0.3	238.29
sPHENIX readout R&D (+Plan-B)	178					
DAQ integration	82.2					
						0
ALICE Readout Teststand	40			Alice production		0
SamTec cables	2.4		28	Alice production	0.3	36.4
Optical links	0.6		43.2	Alice production	0.3	56.16
						0
LVPS etc	27.4		61.6	Alice production	0.3	80.08
Racks	7.4					0
Chiller & Cooling Plant	52	51	118.6	Alice production; may need to modify them to fit sPHENIX	0.3	154.18
Safety system	29.2	56				
Mechanical integration	182	158.6			0	0
Mechanical Prototype		50				
Assembly Jigs	34.4	41.4	101	Alice production; may need to modify them to fit sPHENIX	0.3	131.3
Test beam						
						0
End wheels			35.6	Alice production	0.3	46.28
Cylindrical Structure Shells			12.6	Alice production	0.3	16.38
Detector half barrels			14.6	Alice production	0.3	18.98
Service half barrels			121.6	Alice production	0.3	158.08
Detector and Service Half Barrels			22.6	Alice production	0.3	29.38
Two Half Support Structures			51.6	Alice production; may need to modify them to fit sPHENIX	0.3	67.08
Total	782	357	2212.3			2875.99

Cost Basis – Major Items



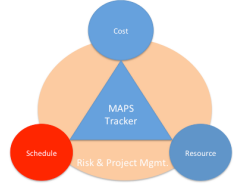
- MAPS and Staves
 - ALICE ITS production
- Readout
 - ALICE ITS RDO and CRU production
- Electronics Interface to sPHENIX/DAQ
 - FVTX/PHENIX experience
- Slow control, DCM-II etc.
 - FVTX/PHENIX experience
- Mechanical structures and cooling
 - ALICE ITS inner tracker design
 - FVTX/PHENIX experience

Major Item R&D Costs

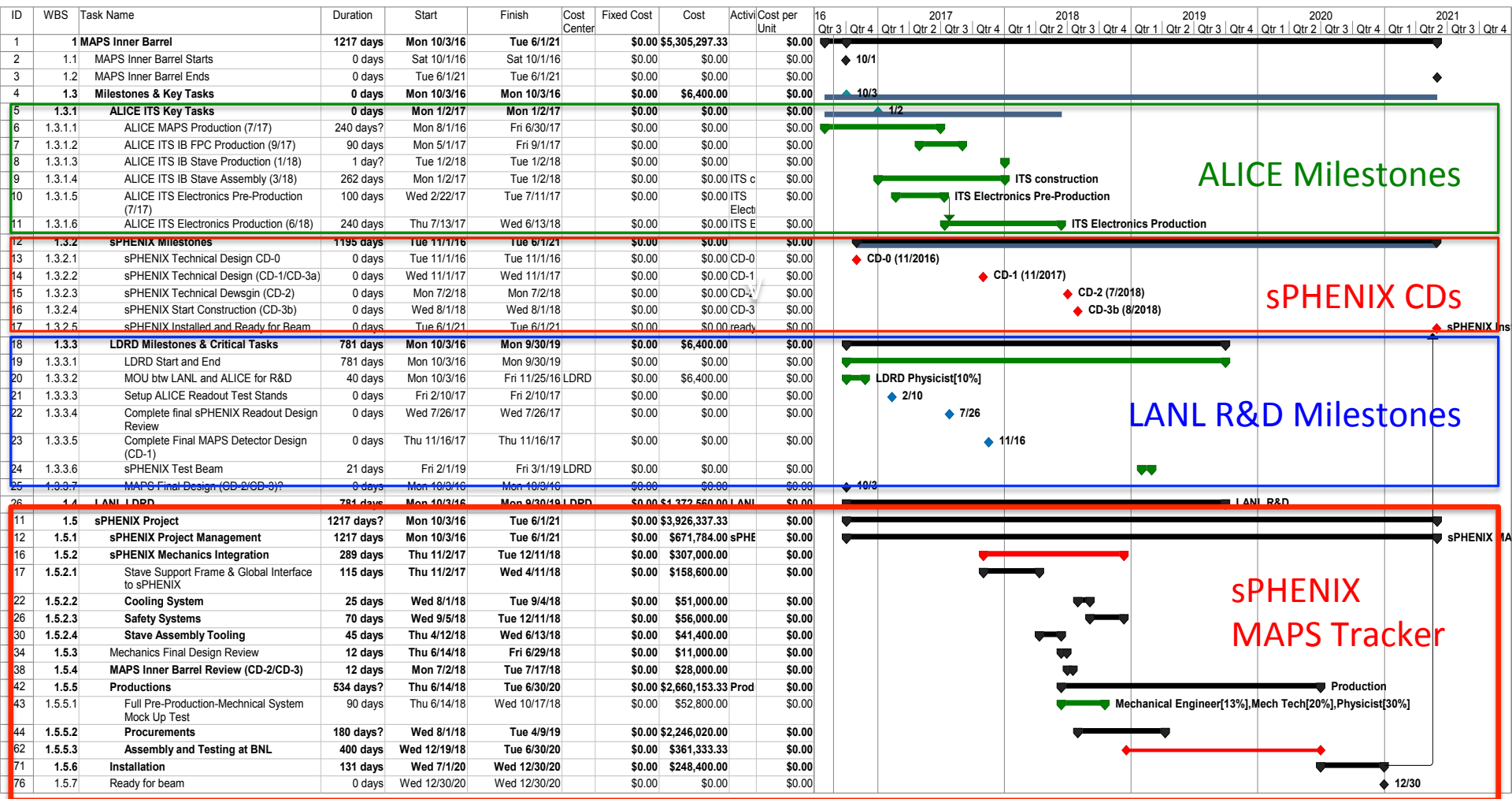


- LANL LDRD-DR: \$780K
 - \$1.1M/year for 3 years (FTE's and M&S)
 - DAQ Interface: \$540K
 - Mechanics: \$240K
- BNL sPHENIX R&D: \$360K
 - Mechanical design and integration: \$310K
 - Mechanical prototype: \$50K

Overview of Schedules

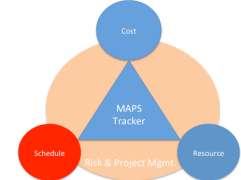


Fri 8/26/16

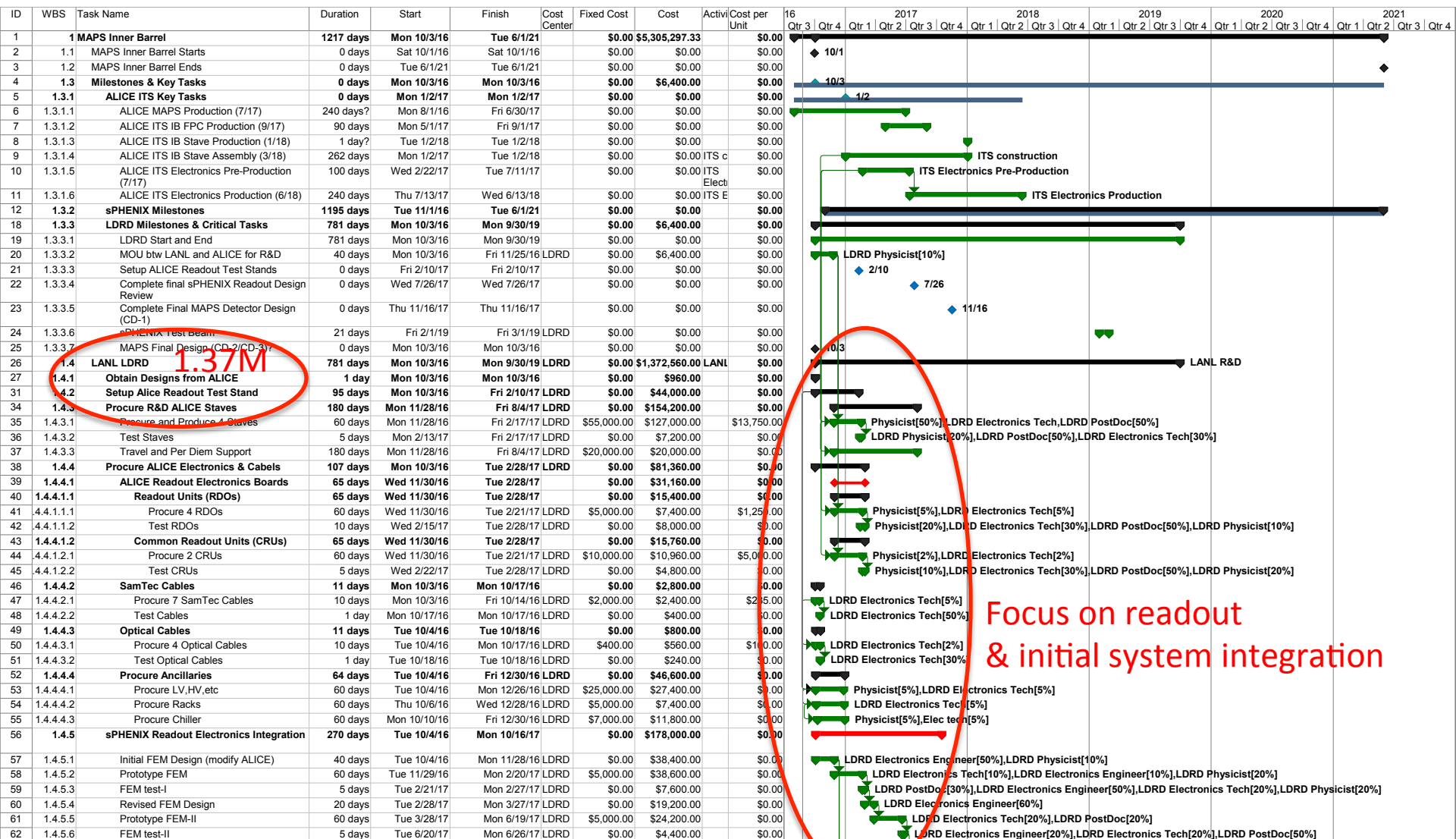


About 6 months on schedule contingency

LANL R&D Schedule



Fri 8/26/16

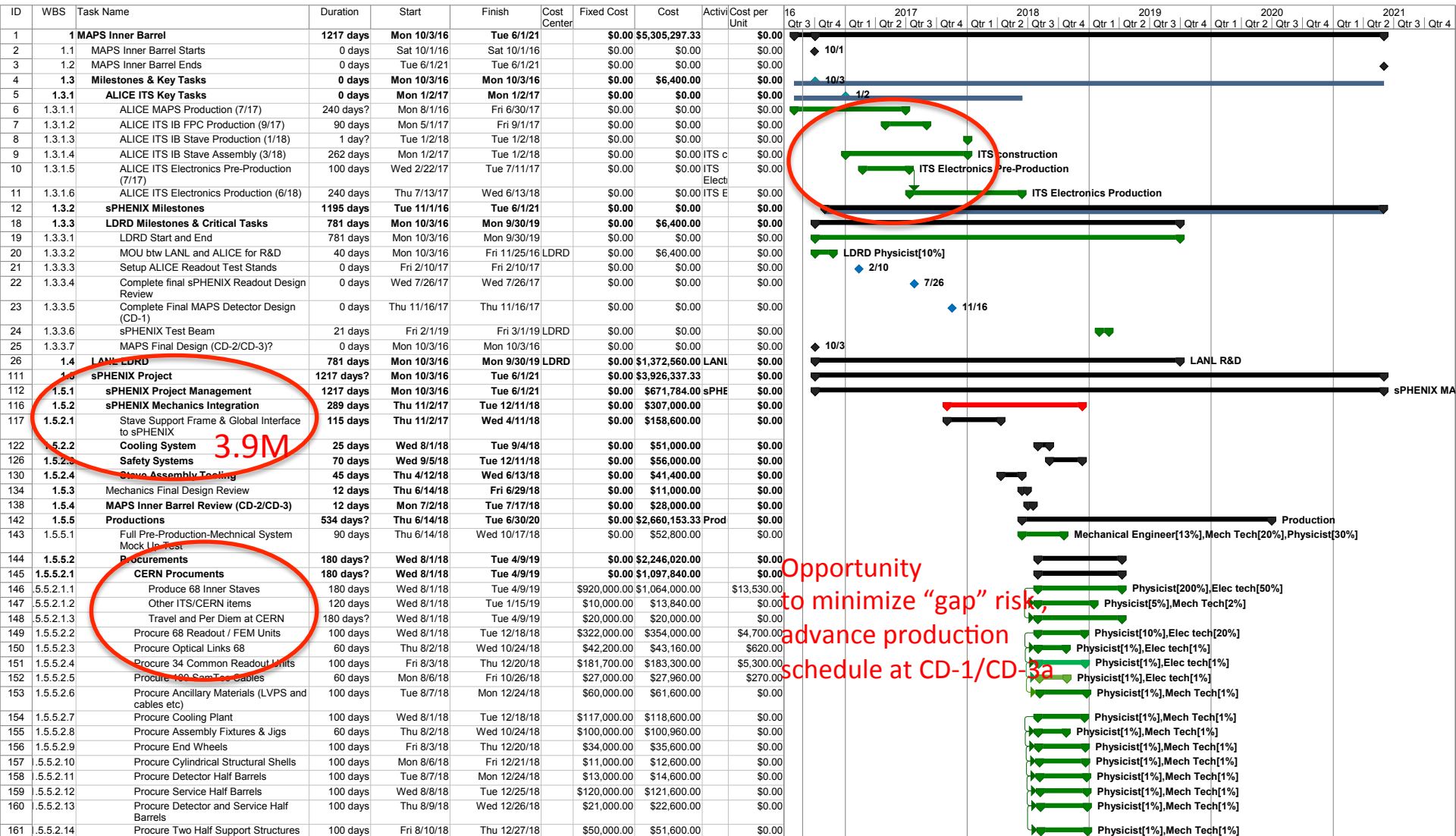


Focus on readout
& initial system integration

Production

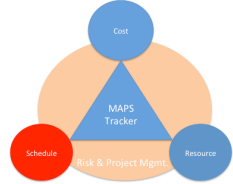


Fri 8/26/16

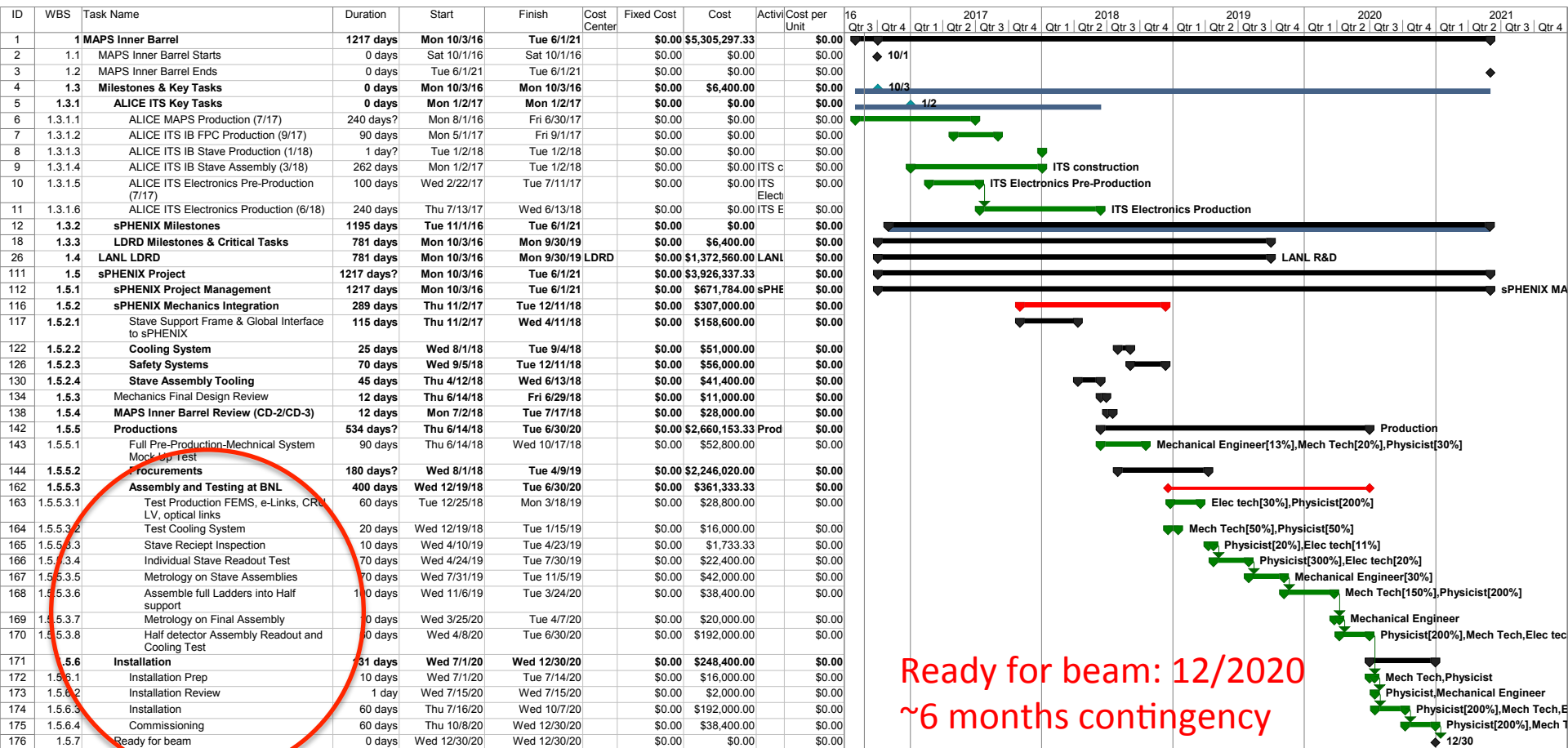


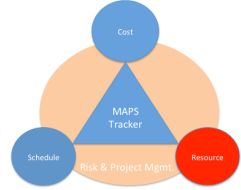
Opportunity to minimize "gap" risk, advance production schedule at CD-1/CD-3a

Assembly and Installation



Fri 8/26/16

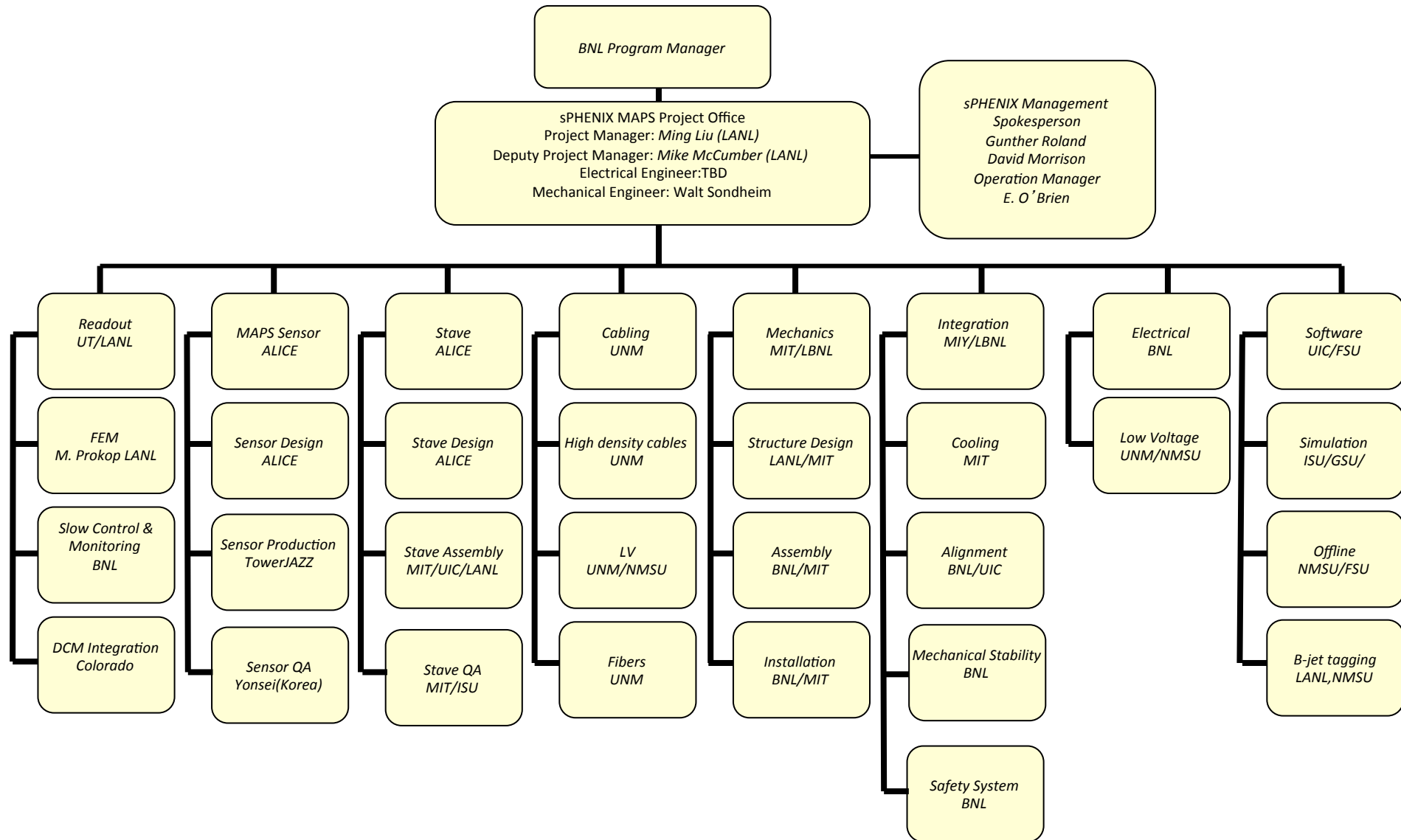




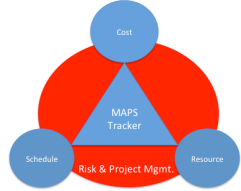
Participating and Interested Institutions

- [LANL](#) - Readout & FEMs, Mechanics
- [MIT](#) - Assembly and testing, cooling
- [LBNL](#) – Mechanical carbon structures, readout
- [BNL](#) – Integration and services, safety and monitoring
- [UT-Austin](#) – MAPS readout electronics and testing
- [Univ. of Colorado](#) – sPHENIX DAQ/DCM-II integration
- [Univ. of New Mexico](#) – LV, cabling & connectors
- [New Mexico State University](#) – Tracking algorithm and simulations
- [Univ. of IL of Chicago](#) – Stave assembly and testing, offline analysis
- [Iowa State University](#) – Assembly and testing, simulations
- [Georgia State University](#) - Slow control and monitoring
- [Florida State University](#) - Offline and simulations
- [Univ. of California, Los Angeles](#) – Assembly and testing, simulations
- [Univ. of California, Riverside](#) – Assembly and testing, simulations
- [RIKEN/RBRC, Japan](#) – Assembly and testing, integration
- [Yonsei, Korea](#) – MAPS QA and readout, simulations

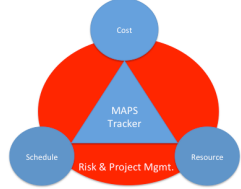
Organization Chart



Risk Based Contingency



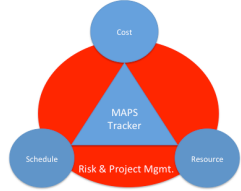
Risk Factor	Technical	Cost	Schedule	Design
0	Not used	Not used	Not used	Detail design > 50% done
1	Existing design and off-the-shelf H/W	Off-the-shelf or catalog item	Not used	Not used
2	Minor modifications to an existing design	Vendor quote from established drawings	No schedule impact on any other item	Not used
3	Extensive modifications to an existing design	Vendor quote with some design sketches	Not used	Not used
4	New design; nothing exotic	In-house estimate based on previous similar experience	Delays completion of non-critical subsystem item	Preliminary design >50% done; some analysis done
6	New design; different from established designs or existing technology	In-house estimate for item with minimal experience but related to existing capabilities	Not used	Not used
8	New design; requires some R&D but does not advance the state-of-the-art	In-house estimate for item with minimal experience and minimal in-house capability	Delays completion of critical path subsystem item	Conceptual design phase; some drawings; many sketches
10	New design of new technology; advances state-of-the-art	Top-down estimate from analogous programs	Not used	Not used
15	New design; well beyond current state-of-the-art	Engineering judgment	Not used	Concept only



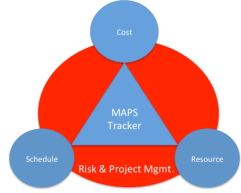
Risk Management

- Readout electronics R&D to meet CD1 (11/2017)
 - Early procurements of staves and RDO/CRU
 - Joint effort with LBNL/ALICE
- Mechanical & cooling R&D to meet CD2/CD3 (8/2018)
 - Early R&D support at BNL
 - sPHENIX mechanical integration
 - Early joint R&D with BNL/LBNL/MIT
- Production
 - Partial delivery and more parallel efforts

Open Issues



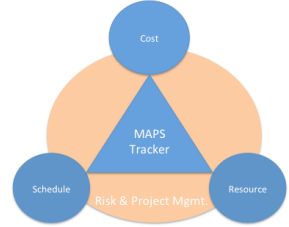
- **MoU with ALICE/CERN: by ~12/2016**
 - Prototype and final stave production and delivery
 - Obtain ALICE readout test stand and electronics for early R&D
 - Obtain design files, electronics and mechanics
 - Training sPHENIX personnel, available manpower
 - R&D collaboration and schedule
 - Availability of CERN facilities after ITS/IB production
- **Schedule/funding gap of stave productions**
 - ITS/IB production: ~1/2017-1/2018
 - sPHENIX CD-3b: 8/2018
 - Risk Mitigation:
 1. Early procurement of MAPS & staves at CD1/CD-3a
 2. Early training through LDRD effort, maintain activity at low level
 3. Possible mortgage for sPHENIX production from ALICE/CERN, MoU
 4. Seek external foreign funding
- **sPHENIX readout R&D**
 - Possible delay due to unavailability of key elements like staves and readout for R&D
 - Risk mitigation:
 - Early joint R&D with ALICE as associate members
 - Start with prototype RDO and CRU



Risk Registry

- Availability of Stave and Readout Electronics from ALICE for early R&D work
- Availability of R&D fund for Mechanics integration design and prototype for CD2/3
- Funding profile

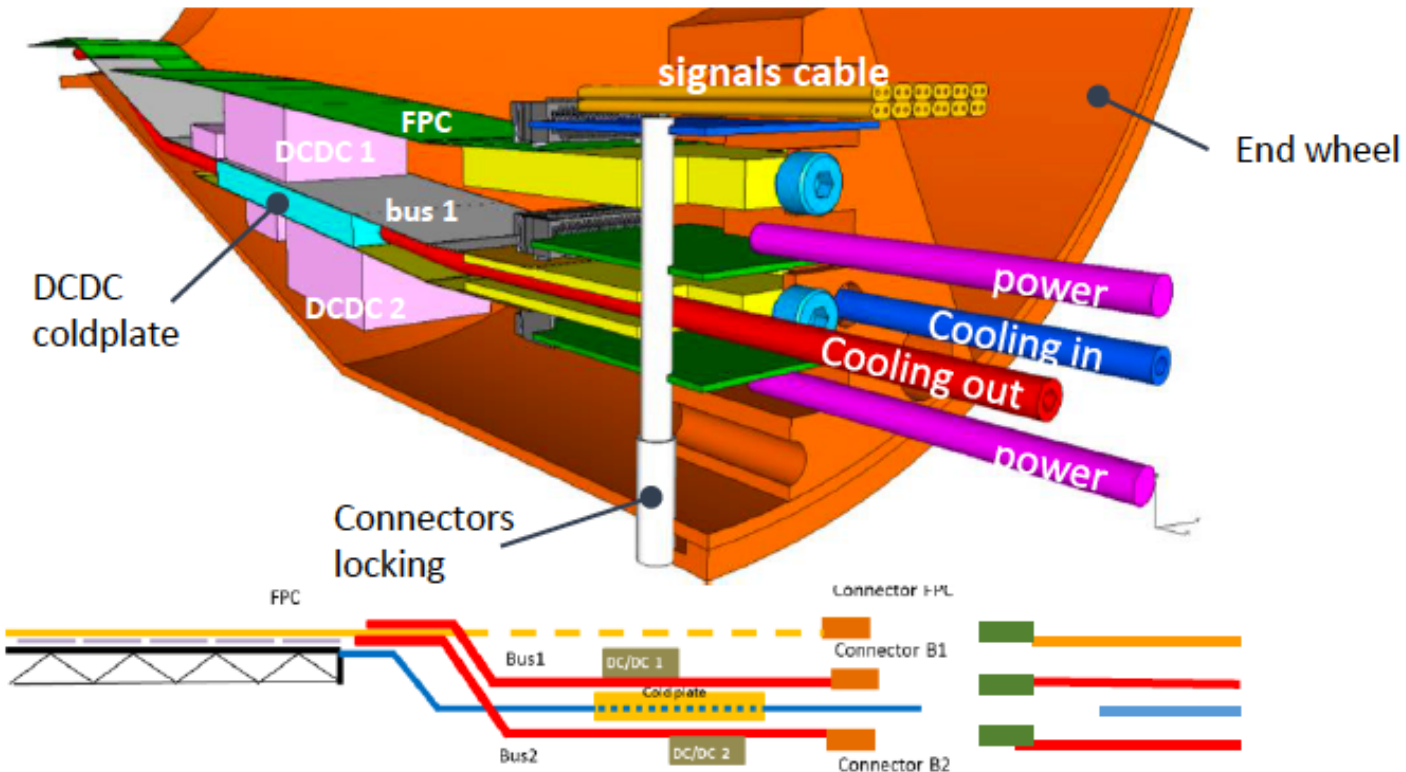
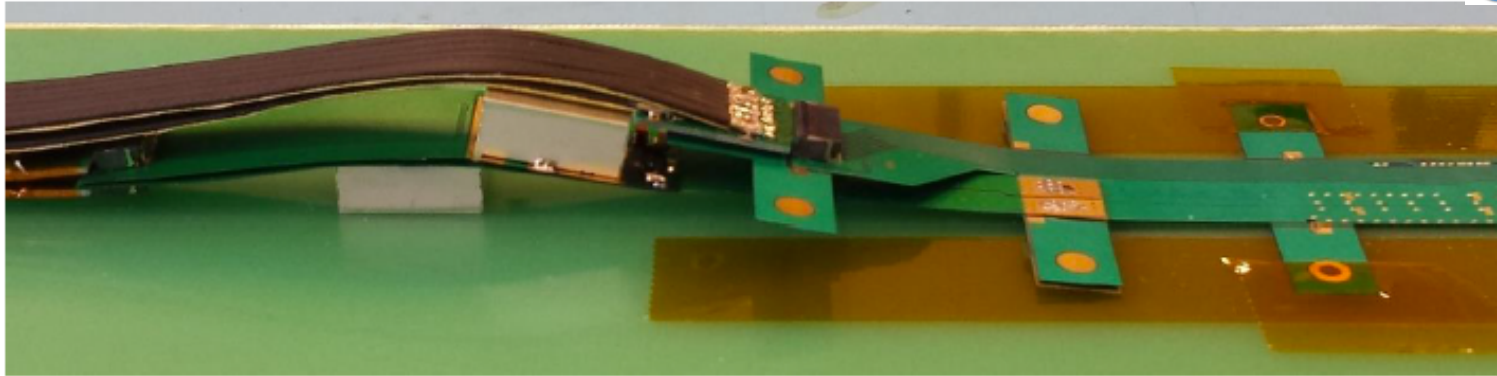
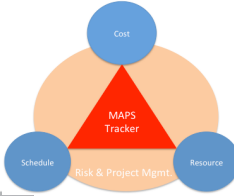
Summary



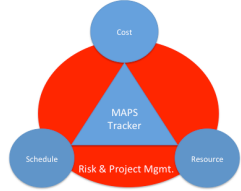
- No high risk R&D necessary
- Early MoU with ALICE critical
- LANL LDRD very important
- Early mechanical integration R&D important
- Cost basis is in reasonable shape
- Management plan is in progress
- Installed and ready for beam ~1/2021
- Schedule has ~6 months contingency

Backup Slides

MAPS Service Lines



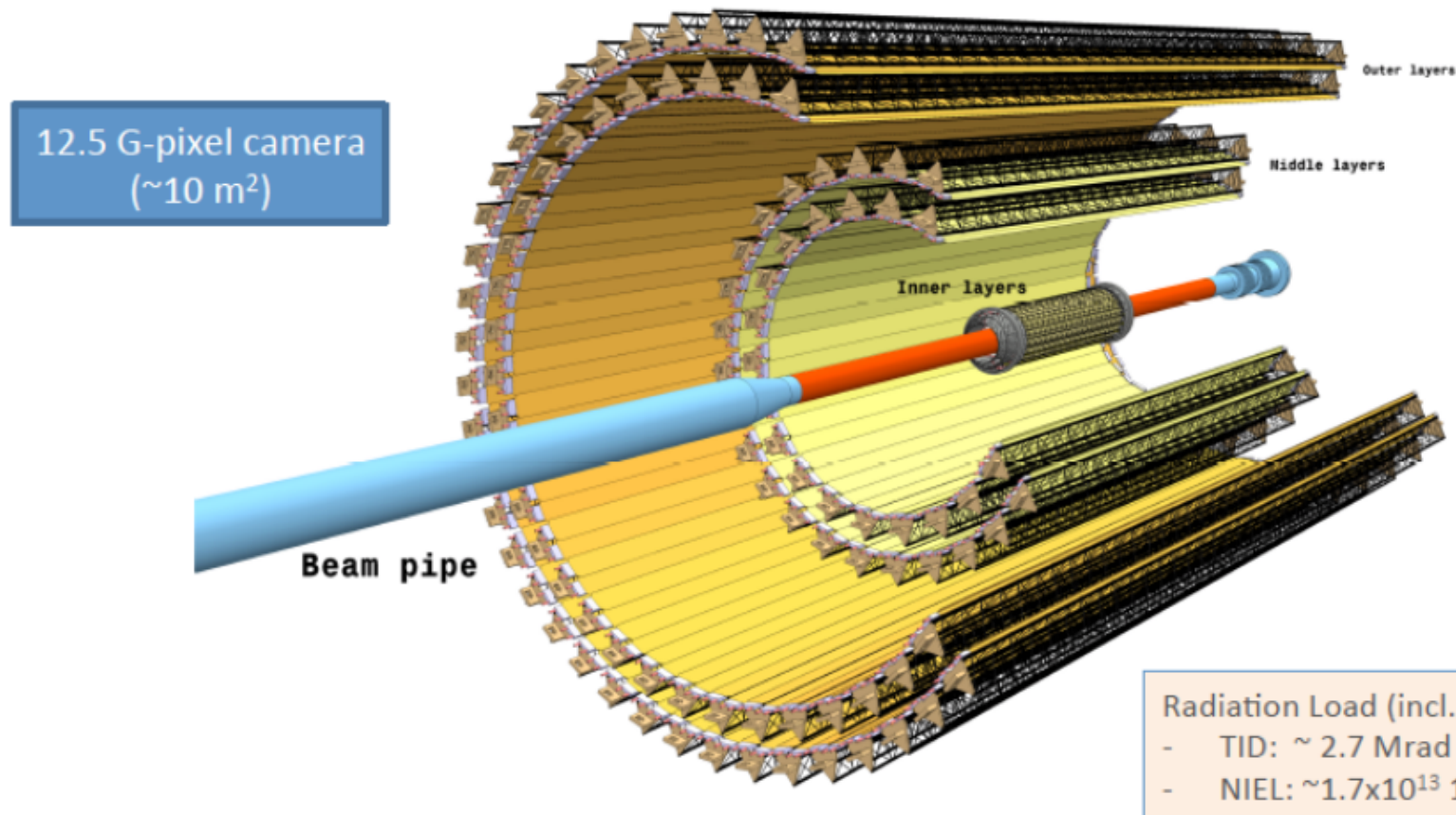
Risk Factors



- Products from ALICE
 - Copies: low risk ~1 (20% Cont.)
 - Some minor modification: medium risk ~2 (30% cont.)
 - New readout board R&D: high risk ~3 (50-100% cont.)
- sPHENIX and ITS/ALICE schedules
 - R&D
 - Production
 - CERN facilities
 - Funding profile
- Long development time for readout boards etc.

New ITS Layout

A Large Ion Collider Experiment



7-layer barrel geometry based on CMOS Sensors

r coverage: 23 – 400 mm

η coverage: $|\eta| \leq 1.22$

for tracks from 90% most luminous region

3 Inner Barrel layers (IB)

4 Outer Barrel layers (OB)

Material /layer : 0.3% X_0 (IB), 1% X_0 (OB)

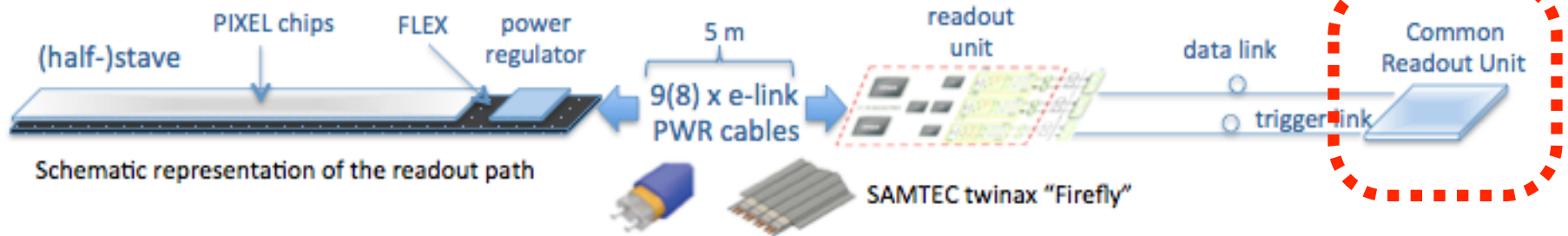
sPHENIX

3-Layer vs 2-Layer

- Cost reduction
 - Stave and electronics cost and schedule
 - Saving \$626K
- 3 Layers: total \$1,602K
 - $(12+16+20)+20 = 68$ staves
 - Cost: $\$920+\$144 = \$1,064\text{K}$
 - Schedule: 180 days
 - 68 RDOs:
 - Cost: $\$322+\$32 = \$354\text{K}$
 - 34 CRUs:
 - Cost: $\$182+\$2 = \$184\text{K}$
- 2 Inner Layers: total = \$964K
 - $(12+16)+12$ ALICE layers 0 & 1 = 40 staves
 - Cost: $40/68 \times \$1,064\text{K} = \626K
 - Schedule: 106 days
 - 40 RDOs
 - $40/68 \times \$354\text{K} = \208K
 - 24CRU:
 - $24/34 \times \$184\text{K} = \130K

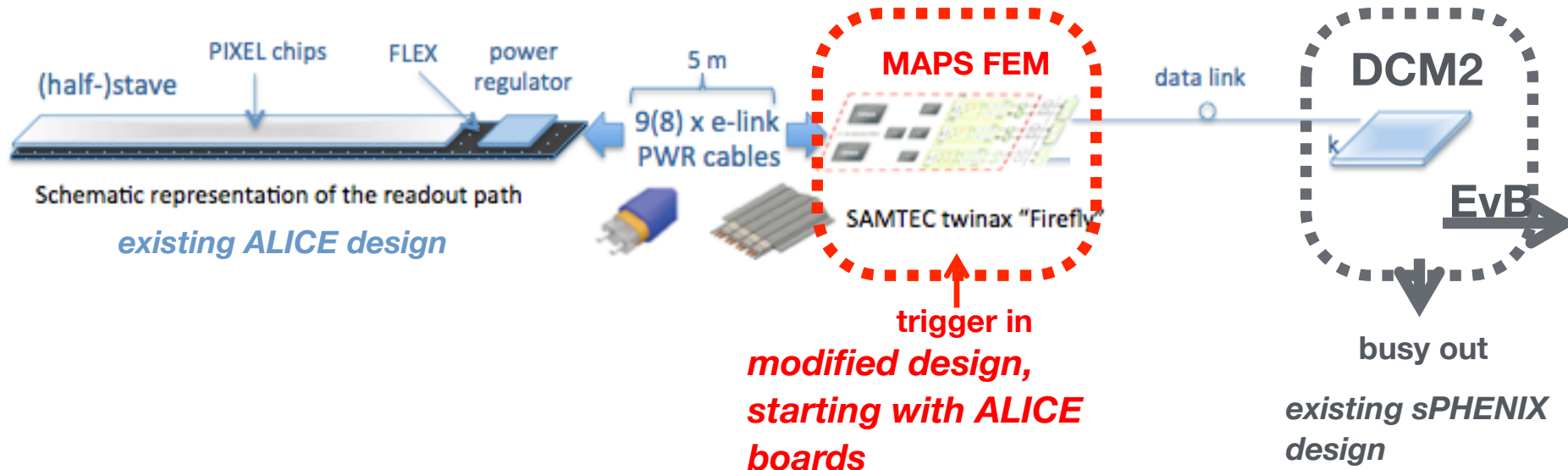
MAPS Electronics

ALICE readout path



Plan A:
reprogram

Plan B: sPHENIX readout path (held as contingency)



Collaboration & Management

- Workshops organized in Santa Fe, 4/2016
 - Strong support from ITS/ALICE and other groups
 - LBNL, BNL STAR/HFT group
 - MIT, Yonsei / Korean Institutions
 - Produced 1st draft of Cost and Schedule project file
 - Established collaboration with ALICE ITS groups
- MAPS Detector Group Kickoff Meeting 8/19/2016
 - Institutions and their interest
 - Resources and plan
- US institutions
 - MIT HI and ME groups
 - Stave assembly and test at CERN & BNL, cooling, integration etc.
 - LBNL
 - mechanical carbon frame etc
 - BNL
 - Services, DAQ, safety, tech support etc
 - UNM and NMSU
 - Cabling, assembly, simulations and physics analysis
 - U Colorado
 - DAQ and DCM-II integration, simulations and analysis
 - ISU
 - Simulations and analysis, assembly and test
 - GSU
 - Simulations, small controls
 - FSU
 - Offline
 - U California, Riverside/LA/Davis etc
 - Local mechanical and electronics shops, simulations, assembly and test
 - UT Austin
 - Readout electronics
 - UIC
 - Assembly and test, offline
- Other international collaborators
 - RIKEN/RBRC – assembly, test and simulations
 - CCNU/ALICE/ITS
 - Yonsei/ALICE/ITS

Working on MOU with ITS/ALICE

- Initial discussion with ITS Management
- Associate Membership on ITS/ALICE project
- Obtain 4 staves & readout for R&D ASAP
- Stave production extension, schedule and “mortgage”
- Obtain readout design files
- Mechanical design files
- sPHENIX manpower at CERN
- 2 presentations planned
 - 9/1/2016: ALICE Management Board meeting
 - 11/11/2016: ALICE Collaboration Board meeting

Expect MOU agreement: 12/2016

LANL/sPHENIX – ALICE Collaboration

From: Luciano Musa <luciano.musa@cern.ch>

Date: Saturday, August 6, 2016 at 9:25 PM

To: "Ming Liu (LANL)" <ming@bnl.gov>

Subject: Re: ALICE ITS MAPS project and sPHENIX - ALICE Associate Membership?

Dear Ming,

sorry for the late reply to your previous e-mail. We had two Engineering Design Reviews (mechanics and cooling) and then I was in Jakarta for one week for an ITS Asian Meeting.

I am glad to learn that you succeed obtaining a \$5M grant (congratulations!!) and your plans to become an ALICE associate member to work in the ITS project. This will require a detailed discussion between the two of us for the preparation of an MoU.

I am leaving today for two weeks of vacation and will be back to CERN on August 22nd. I would propose we get in touch on the 22nd or 23rd August, if this is fine for you.

A possible timeline is presentation of your request at the MB of 1st September and at the CB of 11th November.

Kind Regards,
Luciano

Plan: ITS/ALICE associate members by the end of 2016

TPC

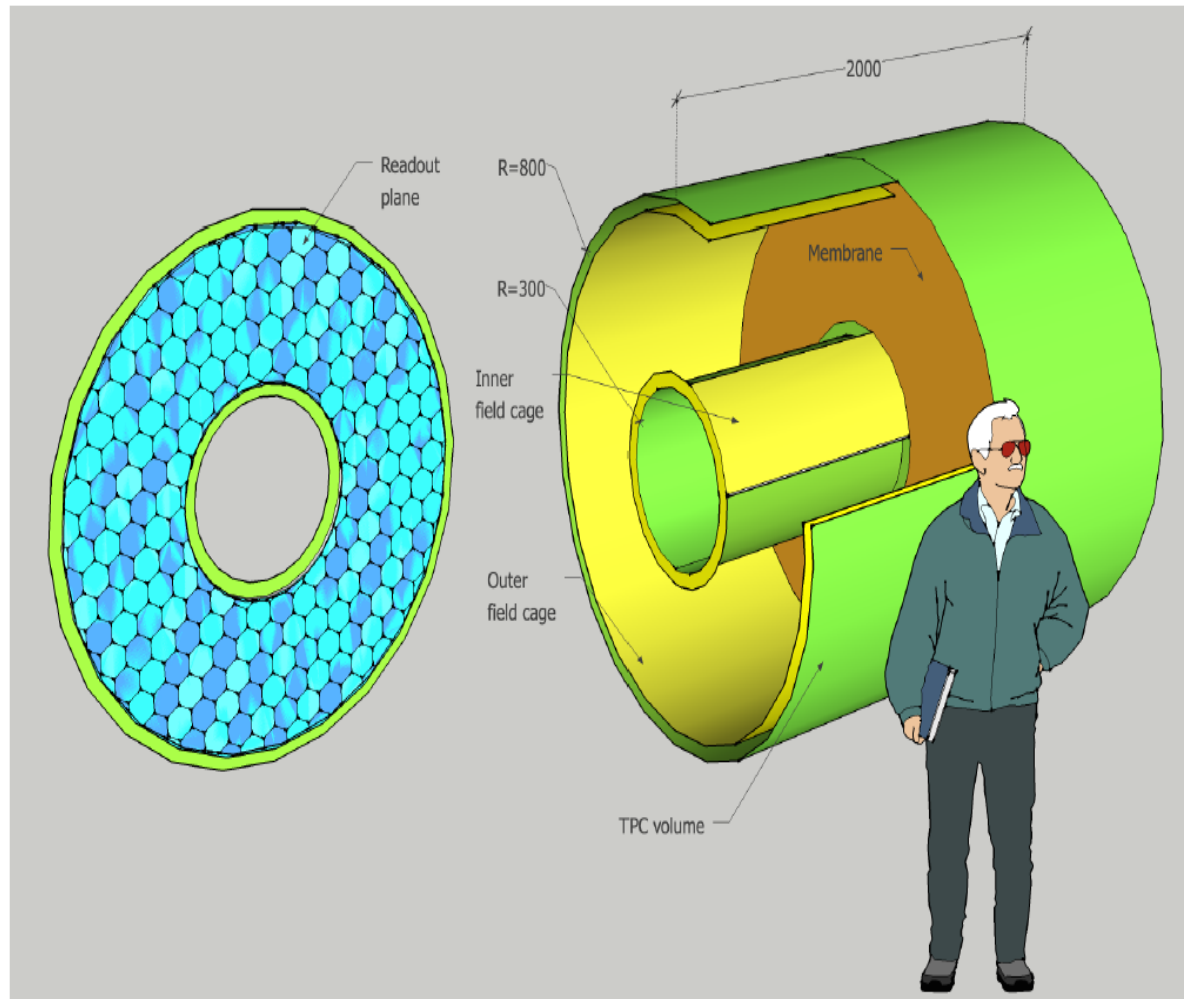
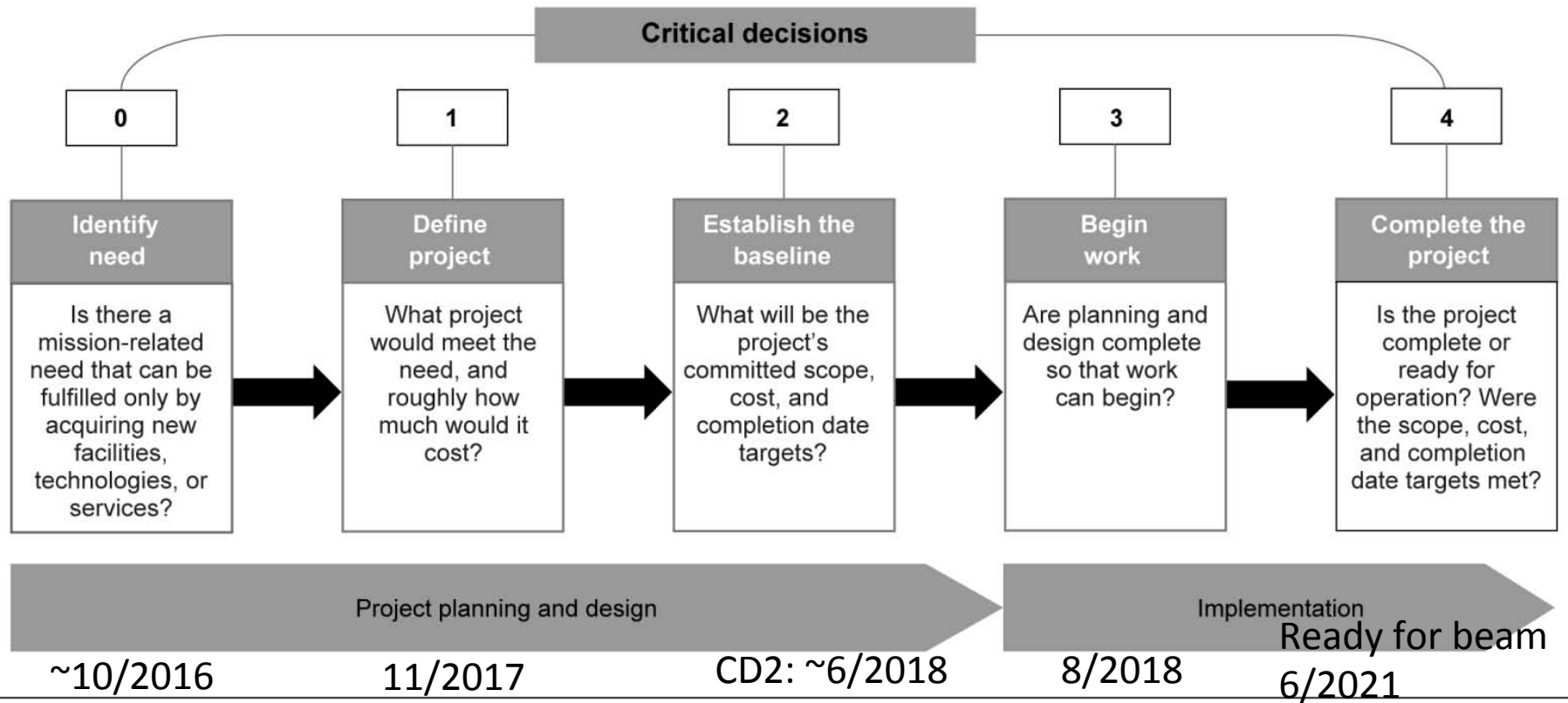


Figure 4.26: Schematic layout of TPC main elements.

Breakout Session Discussion

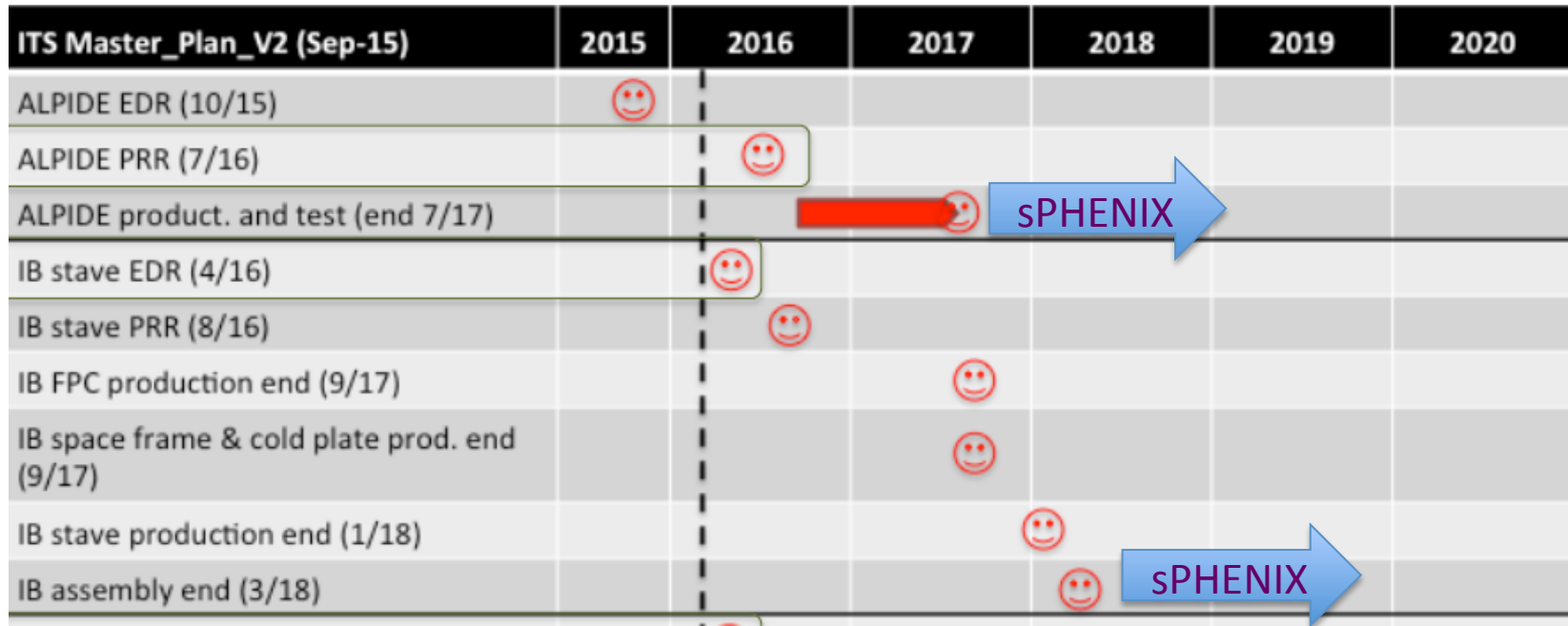
Details of Cost & Schedule

sPHENIX DOE Critical Decision Process



Installation: 2/1
Commissioning: 4/1

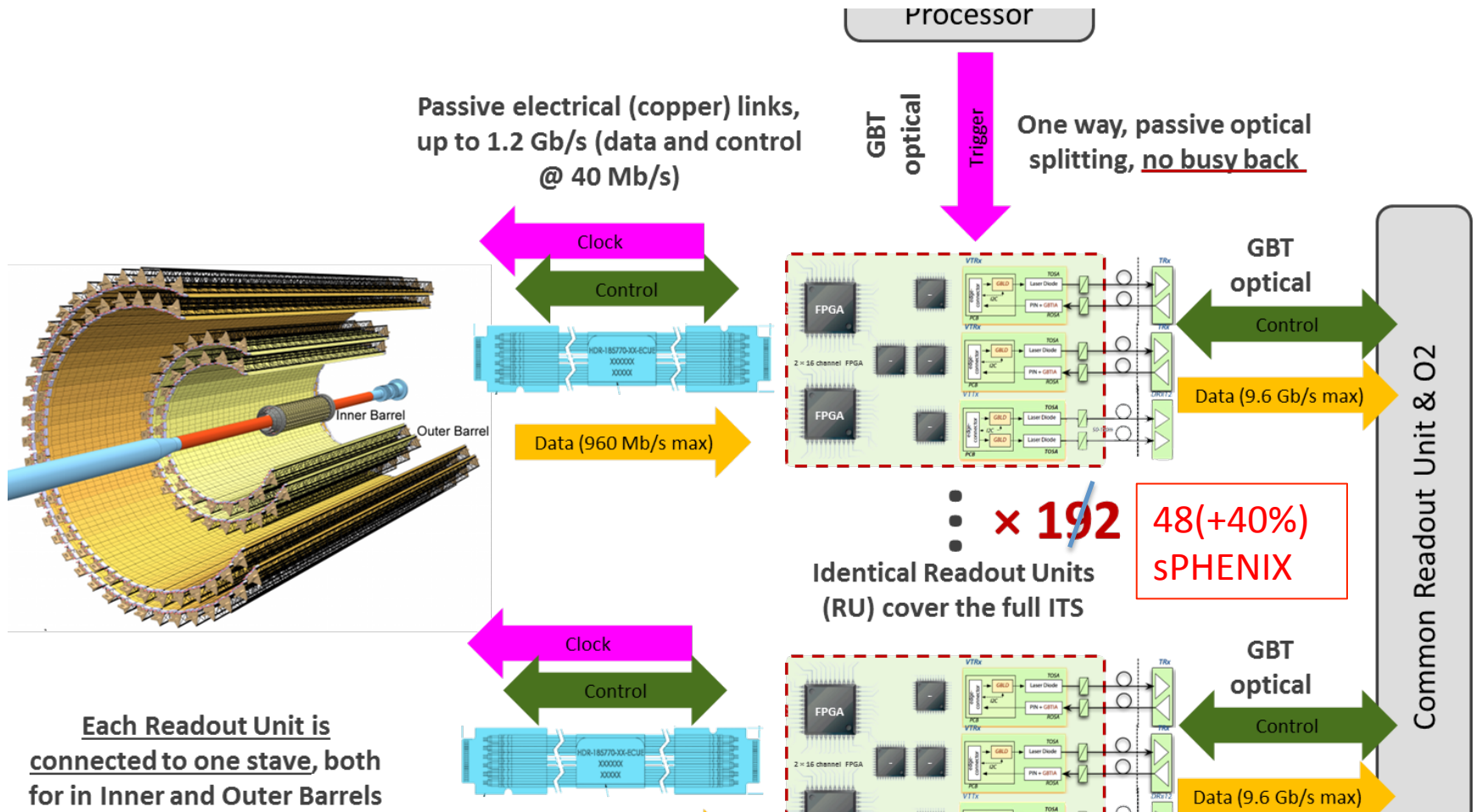
How to mate ALICE and sPHENIX schedules ?



Important to have MoU with ALICE to produce staves for sPHENIX

Cost Basis For Electronics

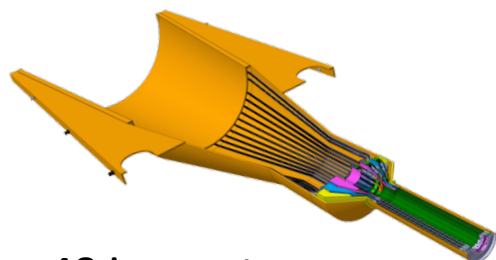
J. Phys. G: Nucl. Part. Phys. **41** (2014) 087002



Readout Units Required for ITS & sPHENIX

Readout Units and GBT links for maximum design rates

Layer	Staves	Copper assemblies	Copper capacity	RUs per stave	RUs per layer	VTRx count	VTTx count	Data fibers	Control fibers	Data fibers capacity	Data fibers usage
			[Gb/s]							[Gb/s]	[%]
0	12	12	103.7	1	12	24	12	36	12	115.2	90.0
1	16	16	138.2	1	16	32	16	48	16	153.6	90.0
2	20	20	172.8	1	20	40	20	60	20	192	90.0
3	24	48	122.9	1	24	48	24	48	24	153.2	80.0
4	30	60	153.6	1	30	60	30	60	30	192	80.0
5	42	168	376.3	1	42	84	42	126	42	403.2	93.3
6	48	196	430.1	1	48	96	48	144	48	460.8	93.3
Total		520	1497.6		192	384	192	576	192	1670	



48 inner staves

48 RDO boards

sPHENIX: 48 +40% = 68

ITS IB:

Produce 120 staves in one year

120% contingency

Key Electronics Readout R&D

- Mostly carried out by LANL LDRD
 - Complete readout electronics design and test by CD-1 (8/1/1017)
- Modify ALICE ITS readout data format to meet sPHENIX DAQ requirements
 - Plan-A:
 - Reprogram CRU to send data directly to PCI/sPHENIX Evt-Builder
 - Plan-B:
 - Build a custom board to convert ALICE data format into sPHENIX DAQ/DCM-II format

Assigned large contingency in both cost and schedule for the readout R&D

Electronics R&D @LANL

- Obtained MAPS v3 at LANL
- R&D lab setup through LANL fund
 - To setup sPHENIX DAQ/DCM-II
 - MAPS readout integration
 - Reuse FVTX FEMS?

1st MAPS prototype sensor being studied at LANL

LBNL R&D expert visited LANL May 2-4th

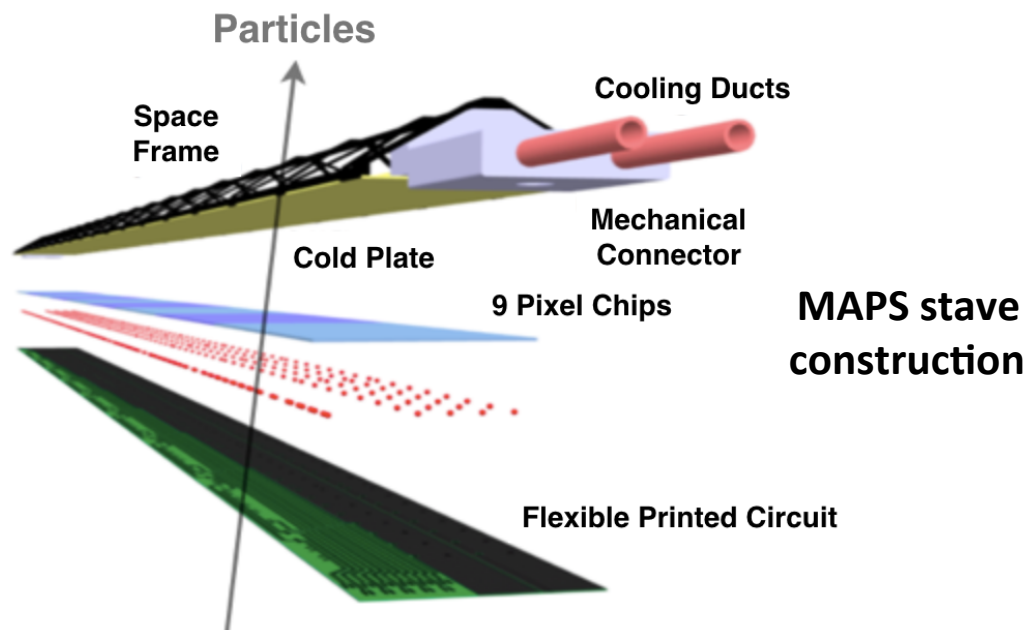
Mike's expertise on DCM-II



R&D Deliverable: a Prototype Tracker

LDRD Experimental Goal: LANL-built 4-stave prototype tracker at test beam with custom sPHENIX readout

1st MAPS prototype sensor
being studied at LANL



Custom front end, integrate into sPHENIX readout (FVTX expertise)

Annual Fermilab Test beam

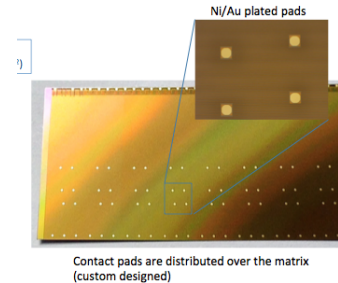
Test prototype tracker
Validate tracking and reconstruction



Critical R&D through LDRD

Extend TowerJazz Production:

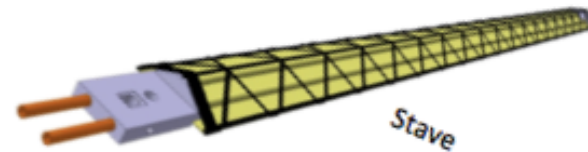
In-kind contribution
525 ALPIDE-final sensors
(inner 3 layers plus ~20% spares)



2x525 ct.

Test Beam Prototype:

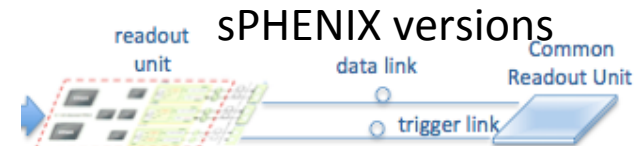
4 full inner ALICE ITS Staves
ALICE readout + common readout boards
small scale power & cooling, jigs, etc



4 ct.

Readout Design:

reprogram CRU for sPHENIX;
or new FEM design for sPHENIX,
replace the ALICE readout board
full-system test with test beam prototype

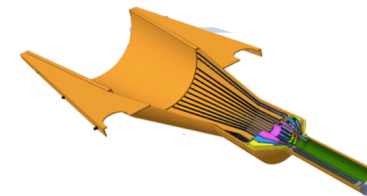


4 ct.

Initial Half-Barrel Mechanical Design:

adapt ALICE inner 3 layer mechanics to sPHENIX
build 3-layer mounts for full-system test

sPHENIX versions



2 ct.

Under LDRD funding:

- Final Detector ~10% populated with staves & readout
- CERN-trained personnel
- Reduce cost of MAPS detector by \$2M!

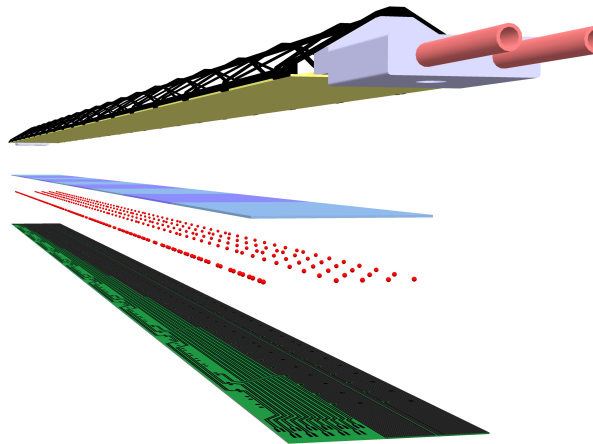
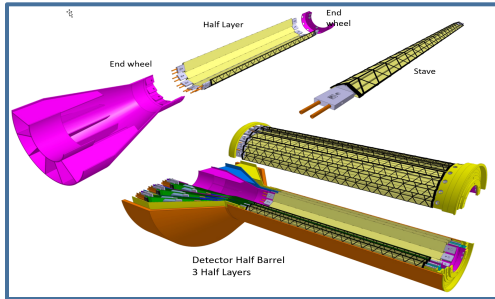
Cost Breakdown - Readout

Activity	M&S (\$K)	Manpower (\$K)	Total (\$K)
68 staves	920	145	1065
68 FEMs	322	32	354
34 CRUs	182	2	184
LVPS, Cables	60	2	62
SamTec cables, Fibers	70	4	74

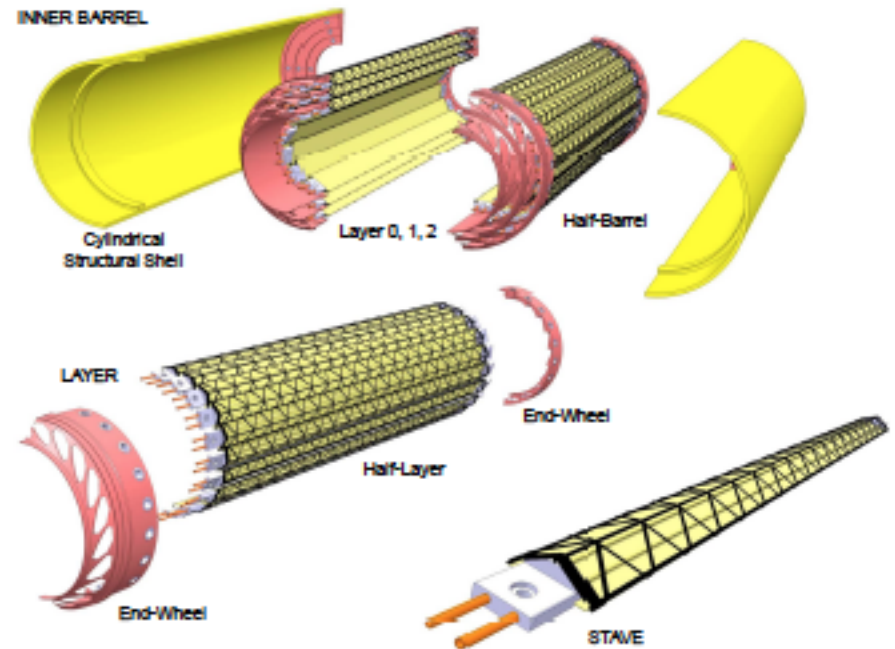
DCM-II: ? \$\$ TBD

Test bench : \$100K

ALICE Stave and Global Support Structure Cost and Schedule Basis



ALICE Stave



(a) ITS Inner Barrel design.

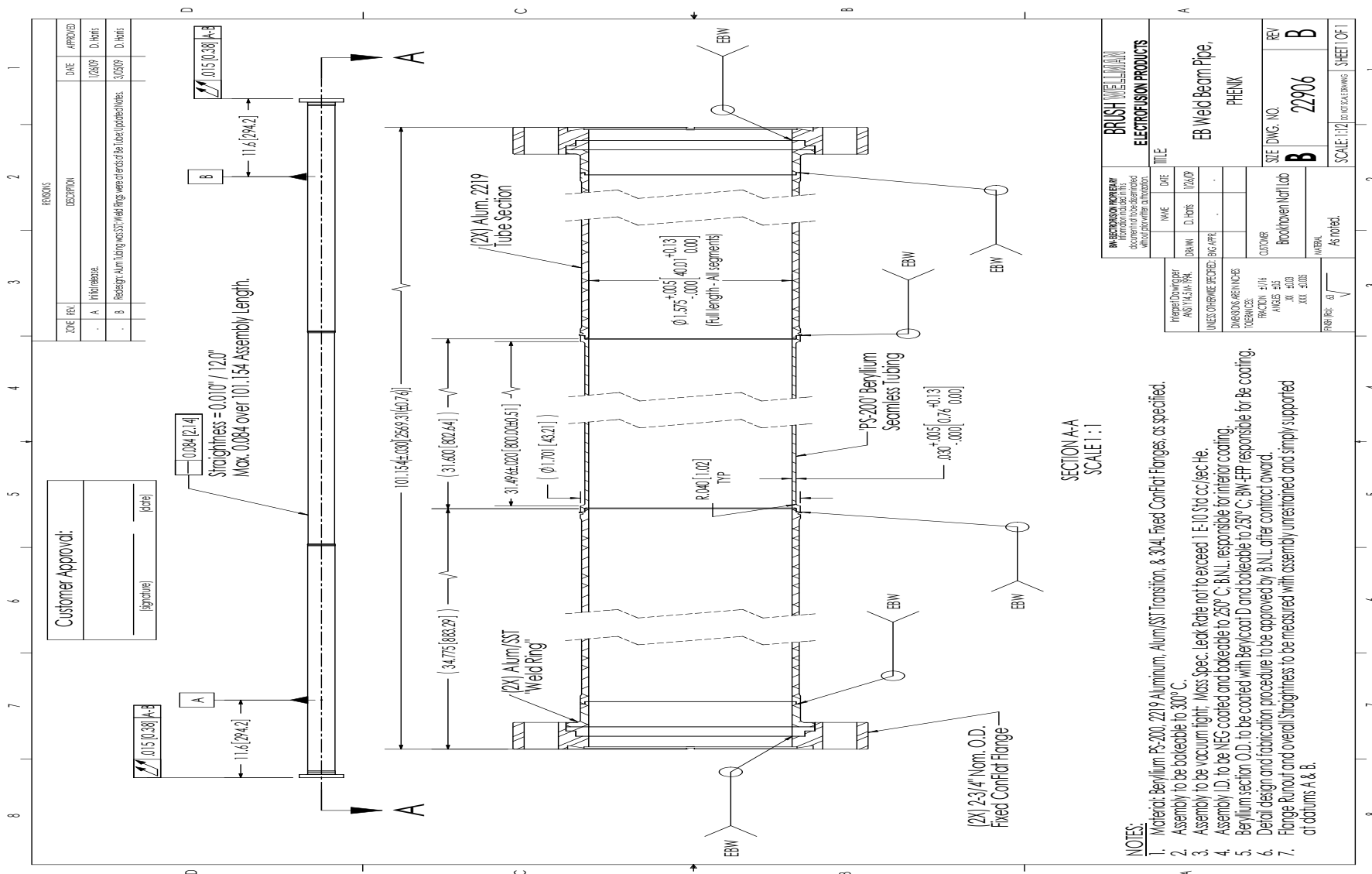
J. Phys. G: Nucl. Part. Phys. **41** (2014) 087002

PHENIX Beam Pipe

$$R_{\text{PHENIX(max)}} = 20.78 \text{ mm}$$

$$R_{\text{ALICE Frame}(\text{min})} = 22.00$$

$$R_{\text{ALICE_MAPS}(\text{min})} = 22.40$$



NOTES:

1. Material: Beryllium P5-200, 2219 Aluminum, Alum/MST Transition, & 304L Fixed Conflat Flanges, as specified.
2. Assembly to be bakeable to 300° C.
3. Assembly to be vacuum tight. Mass Spec. Leak Rate not to exceed 1E-10 Std cc/sec/he.
4. Assembly I.D. to be NEG coated and bakeable to 250° C. B.N.L. responsible for interior coating.
5. Beryllium section O.D. to be coated with Berycoat D and bakeable to 250° C. BM-EPF responsible for flange coating.
6. Detail design and fabrication procedure to be approved by B.N.L. after contract award.
7. Flange Runout and overall Straightness to be measured with assembly unrestrained and simply supported at datums A & B.

Mechanical Integration

- ALICE ITS can fit sPHENIX

- PHENIX beam pipe:

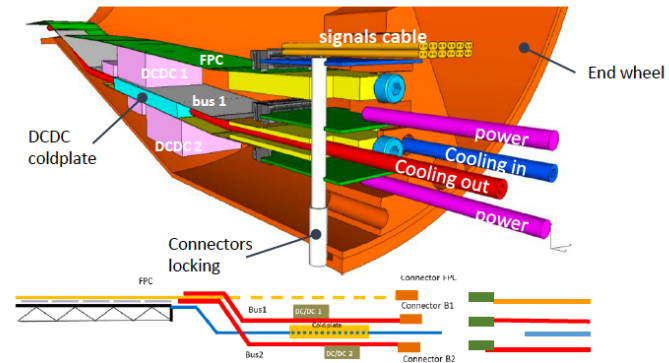
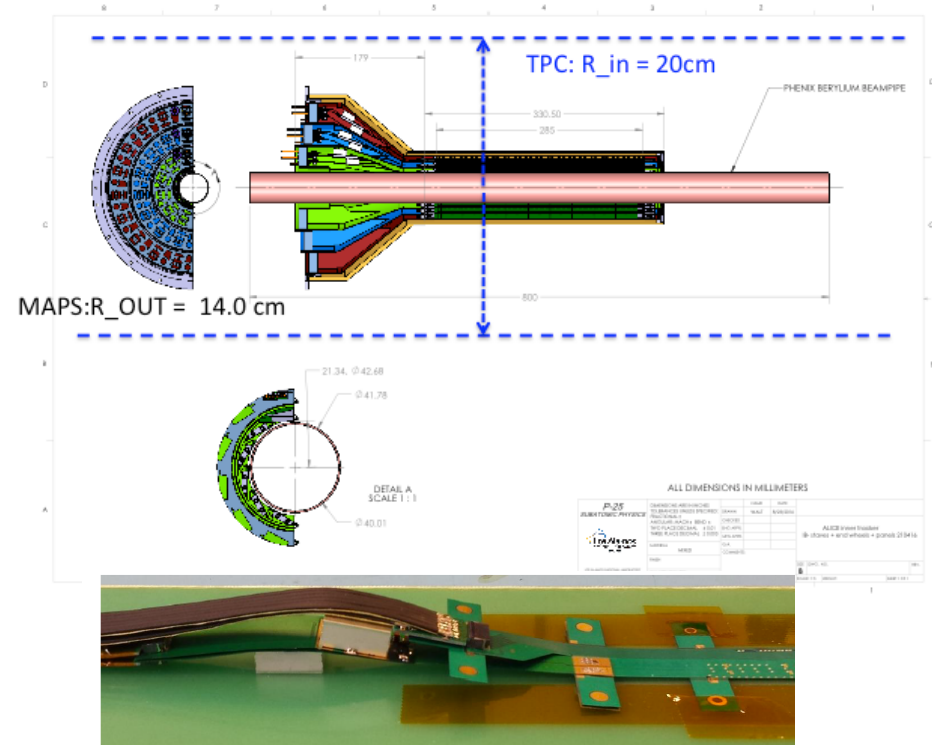
- $R_{out} = 20.78\text{mm}$, $|Z| \leq 40\text{cm}$
 - $R_{ALICE_frame_min} = 22.00\text{ mm}$
 - $R_{MAPS_stave_min} = 22.40\text{ mm}$
 - $Gap_Beam_pipe_ITS = 1.63\text{mm}$

- sPHENIX TPC

- $R_{in} = 20\text{cm}$
 - $R_{ALICE_frame_max} = 140\text{mm}$

- Potential modification

- Extend service structure for cables/cooling lines

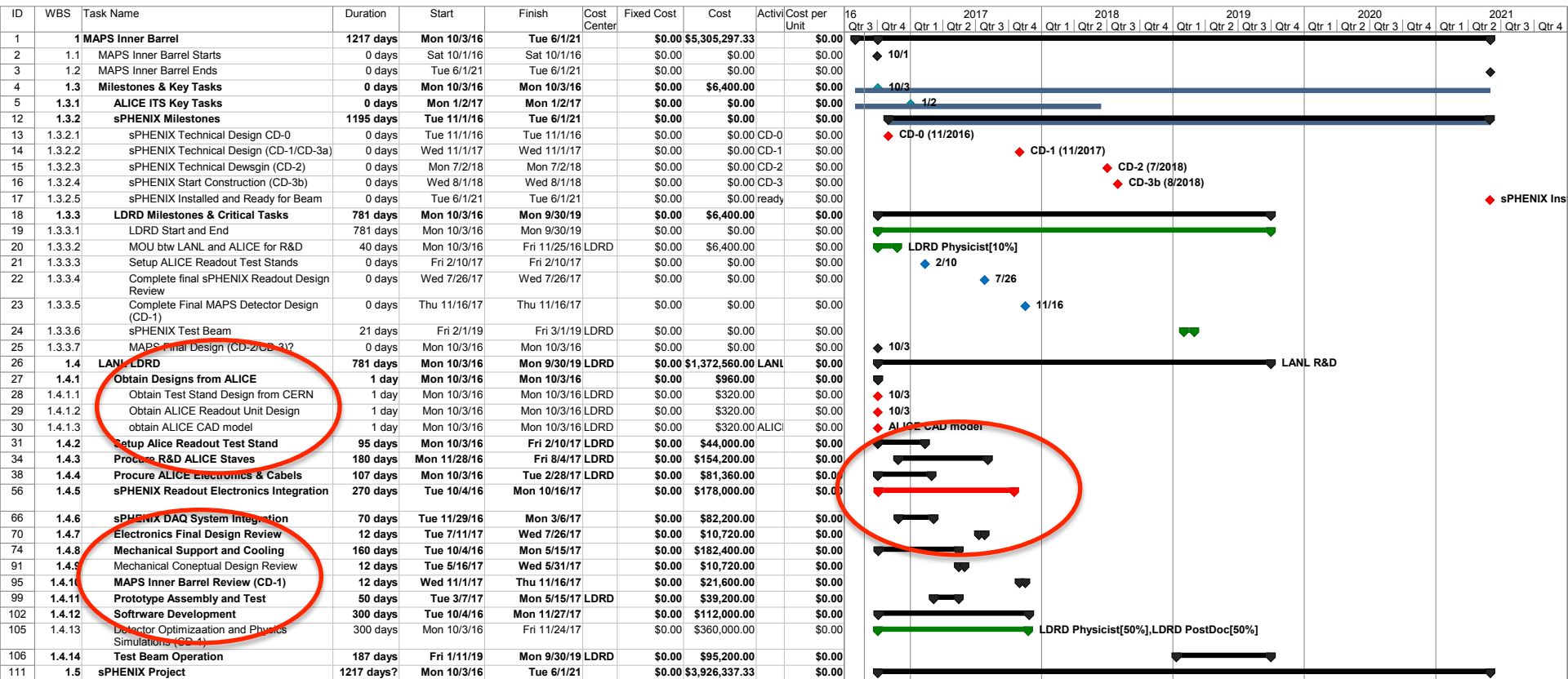


Schedule of Mechanics

- Early R&D carried out by LANL LDRD
 - Conceptual design for CD-1
 - Cooling system prototyping for CD-2
- DOE Project
 - Carry out final mechanical design and system
 - Stave frames and support structure
 - Cooling
 - Cable layout
 - To meet the CD2/3 schedules, early R&D fund needed for integration design work

LANL R&D

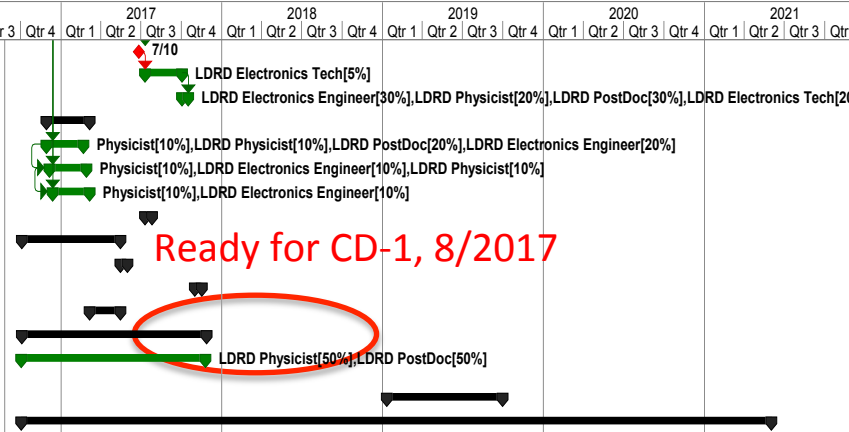
Fri 8/26/16



LANL R&D (II)

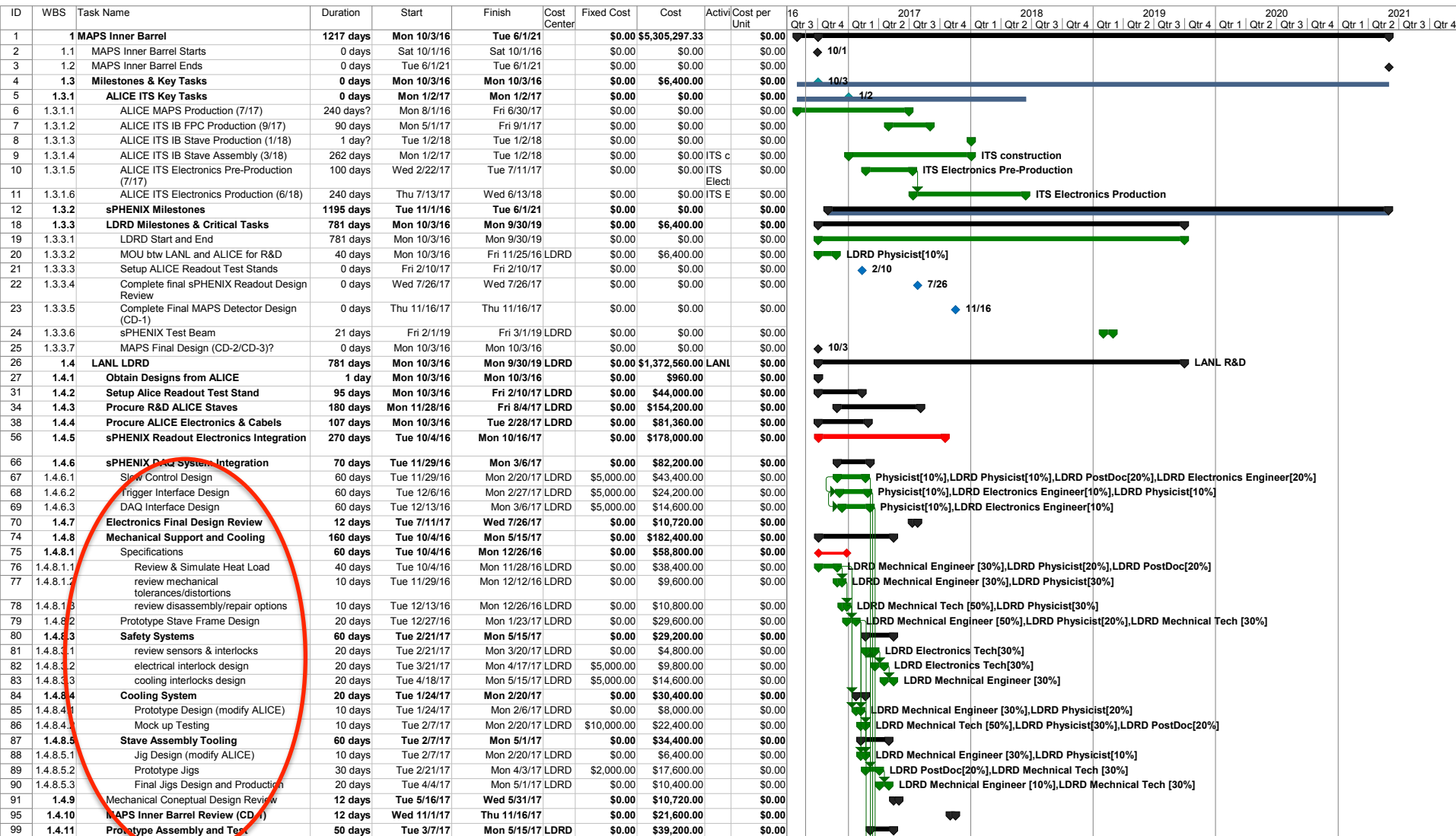
Fri 8/26/16

ID	WBS	Task Name	Duration	Start	Finish	Cost Center	Fixed Cost	Cost	Activ	Cost per Unit	16	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4
63	1.4.5.7	Final FEM design (CD-1)	10 days	Mon 6/26/17	Mon 7/10/17	LDRD	\$0.00	\$11,200.00		\$0.00																							
64	1.4.5.8	Procure 4 FEMs	60 days	Tue 7/11/17	Mon 10/2/17	LDRD	\$20,000.00	\$22,400.00		\$5,000.00																							
65	1.4.5.9	Final FEM Test	10 days	Tue 10/3/17	Mon 10/16/17	LDRD	\$0.00	\$12,000.00		\$0.00																							
66	1.4.6	sPHENIX DAQ System Integration	70 days	Tue 11/29/16	Mon 3/6/17		\$0.00	\$82,200.00		\$0.00																							
67	1.4.6.1	Slow Control Design	60 days	Tue 11/29/16	Mon 2/20/17	LDRD	\$5,000.00	\$43,400.00		\$0.00																							
68	1.4.6.2	Trigger Interface Design	60 days	Tue 12/6/16	Mon 2/27/17	LDRD	\$5,000.00	\$24,200.00		\$0.00																							
69	1.4.6.3	DAQ Interface Design	60 days	Tue 12/13/16	Mon 3/6/17	LDRD	\$5,000.00	\$14,600.00		\$0.00																							
70	1.4.7	Electronics Final Design Review	12 days	Tue 7/11/17	Wed 7/26/17		\$0.00	\$10,720.00		\$0.00																							
74	1.4.8	Mechanical Support and Cooling	160 days	Tue 10/4/16	Mon 5/15/17		\$0.00	\$182,400.00		\$0.00																							
91	1.4.9	Mechanical Conceptual Design Review	12 days	Tue 5/16/17	Wed 5/31/17		\$0.00	\$10,720.00		\$0.00																							
95	1.4.10	MAPS Inner Barrel Review (CD-1)	12 days	Wed 11/1/17	Thu 11/16/17		\$0.00	\$21,600.00		\$0.00																							
99	1.4.11	Prototype Assembly and Test	50 days	Tue 3/7/17	Mon 5/15/17	LDRD	\$0.00	\$39,200.00		\$0.00																							
102	1.4.12	Software Development	300 days	Tue 10/4/16	Mon 11/27/17		\$0.00	\$112,000.00		\$0.00																							
105	1.4.13	Detector Optimizaation and Physics Simulations (CD-1)	300 days	Mon 10/3/16	Fri 11/24/17		\$0.00	\$360,000.00		\$0.00																							
106	1.4.14	Test Beam Operation	187 days	Fri 1/11/19	Mon 9/30/19	LDRD	\$0.00	\$95,200.00		\$0.00																							
111	1.5	sPHENIX Project	1217 days?	Mon 10/3/16	Tue 6/1/21		\$0.00	\$3,926,337.33		\$0.00																							



LANL Mechanics R&D (I)

Fri 8/26/16



LANL Mechanics R&D (II)

Fri 8/26/16

ID	WBS	Task Name	Duration	Start	Finish	Cost Center	Fixed Cost	Cost	Active	Cost per Unit
100	1.4.11.1	Assemble prototype	30 days	Tue 3/7/17	Mon 4/17/17	LDRD	\$0.00	\$21,600.00		\$0.00
101	1.4.11.2	Prototype Full System Test	20 days	Tue 4/18/17	Mon 5/15/17	LDRD	\$0.00	\$17,600.00		\$0.00
102	1.4.12	Software Development	300 days	Tue 10/4/16	Mon 11/27/17		\$0.00	\$112,000.00		\$0.00
105	1.4.13	Detector Optimization and Physics Simulations (CD-1)	300 days	Mon 10/3/16	Fri 11/24/17		\$0.00	\$360,000.00		\$0.00
106	1.4.14	Test Beam Operation	187 days	Fri 1/11/19	Mon 9/30/19	LDRD	\$0.00	\$95,200.00		\$0.00
107	1.4.14.1	Shipping/Transport	10 days	Fri 1/11/19	Thu 1/24/19	LDRD	\$10,000.00	\$12,400.00		\$0.00
108	1.4.14.2	Setup	5 days	Fri 1/25/19	Thu 1/31/19	LDRD	\$0.00	\$7,800.00		\$0.00
109	1.4.14.3	Operations	20 days	Fri 2/1/19	Thu 2/28/19	LDRD	\$0.00	\$12,000.00		\$0.00
110	1.4.14.4	Test Beam Data Analysis & Publication	152 days	Fri 3/1/19	Mon 9/30/19		\$0.00	\$63,000.00		\$0.00
111	1.5	sPHENIX Project	1217 days?	Mon 10/3/16	Tue 6/1/21		\$0.00	\$3,926,337.33		\$0.00

Cost Breakdown - Mechanics

Activity	M&S (\$K)	Manpower	Total (\$K)
Cooling Plant	117	2	119
Assembly fixtures and Jigs	100	2	102
End Wheels	34	2	36
Cyl. Shells, half barrels etc	24	4	28
Service Half Barrels	141	4	145

sPHENIX Production (II)

Fri 8/26/16

ID	WBS	Task Name	Duration	Start	Finish	Cost Center	Fixed Cost	Cost	Activi	Cost per Unit	16	2017				2018				2019				2020				2021			
											Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4			
162	1.5.5.3	Assembly and Testing at BNL	400 days	Wed 12/19/18	Tue 6/30/20		\$0.00	\$361,333.33		\$0.00																					
171	1.5.6	Installation	131 days	Wed 7/1/20	Wed 12/30/20		\$0.00	\$248,400.00		\$0.00																					
176	1.5.7	Ready for beam	0 days	Wed 12/30/20	Wed 12/30/20		\$0.00	\$0.00		\$0.00																					

Cost Breakdown - Assembly

Activity	M&S (\$K)	Manpower	Total (\$K)
Test FEMs, CRU, LV, etc	0	29	29
Test Cooling sys	0	16	16
Test staves	0	22	22
Metrology of stave assembly	0	42	42
Metrology final detectors	0	20	20
Build half det	0	38	38
Half-det assembly and test; slow control etc		190	190

Cost Breakdown - Installation

Activity	M&S (\$K)	Manpower	Total (\$K)
Preparation	0	16	16
Installation	0	192	192
Commissioning	0	38	38

Backup slides

Projected Future sPHENIX Schedule

Slide from Ed O'Brien 6/24/2016

CD-0	Sept-Oct 2016
Director's Cost and Schedule Review	Late Fall 2016
Test Beam at FNAL(2 nd round prototyping)	Jan 2017
OPA-CD-1/CD-3a Review	May-Jun 2017
CD-1/CD-3a authorization	Nov 2017
All Preproduction R&D and Design complete	May-Jun 2018
OPA- CD-2/CD-3b review	May-Jun 2018
CD-2/CD-3b authorization	Jul-Aug 2018
sPHENIX Installed, cabled, ready to commission	Apr 2021
First RHIC beam for sPHENIX	Jan 2022

The current Resource-loaded Schedule contains **8.5 months of float** to Jan 2022

Inputs from ALICE ITS Project

4/1/2016

- 1) Project Schedule, add 6 months delay
- 2) Cost and FTEs

Cost breakdown

A Large Ion Collider Experiment



ALICE

Activity	Material Costs	Manpower Costs	TOTAL COST / ITEM
<u>1. Pixel Chip</u>	4847	170	5017
1.1 CMOS Wafers	3611		3611
1.2 Thinning & Dicing	800		800
1.3 Series test	436	170	606
<u>2 Inner Barrel</u>	296	262	558
2.1 FPC (construction and test)	23	13	36
2.2 HIC (assembly and test)	250	150	400
2.3 SF & Cold Plate (constr. and test)	3	43	46
2.4 Stave assembly & test	20	56	76
<u>3 Outer Barrel HIC</u>	1447	1118	2565
3.1 FPC (construction and test)	247	88	335
3.2 HIC (assembly and test)	1200	1030	2230
<u>4 Middle Layers Staves</u>	142	322	464
4.1 Powerbus cables	70	3	73
4.2 SF & Cold Plate (constr. and test)	42	113	155
4.3 Stave assembly & test	30	206	236
<u>5 Outer Layers Staves</u>	284	896	1180
5.1 Powerbus cables	127	33	160
5.2 SF & Cold Plate (constr. and test)	97	245	342
5.3 Stave assembly & test	60	618	678

Chips:
1k/50k = 2%
- \$100K

Staves:
68/120 = 60%
-\$340K

Share R&D cost
-\$500K

“Buy staves”
and MoU

Total ~\$1M

Cost breakdown

A Large Ion Collider Experiment



Activity	Material Costs	Manpower Costs	TOTAL COST / ITEM
6 Inner Barrel Global Assembly	70	156	227
6.1 End-Wheels (E-W)	4	30	34
6.2 Assembly of Staves on E-W	16	12	28
6.3 Cylindrical Structural Shell	1	10	11
6.4 Detector Half-Barrels	6	7	13
6.5 Service Half-Barrels	36	84	120
6.6 Detector + Service Half-Barrels	7	14	21
7 Outer Barrel Global Assembly	135	407	542
7.1 ML End-Wheels	13	50	63
7.2 ML Assembly of Staves on E-W	10	21	31
7.3 OL End-Wheels	23	59	82
7.4 OL Assembly of Staves on E-W	12	32	44
7.5 Conyical Structural Shell	8	62	70
7.6 Cylindrical Structural Shell	20	55	75
7.7 Detector Half-Barrels	7	13	20
7.8 Service Half-Barrels	36	85	121
7.9 Detector + Service Half-Barrels	7	30	37
8 Integration in ALICE	91	262	354
8.1 Cage	61	153	215
8.2 Installation Tooling	30	109	139

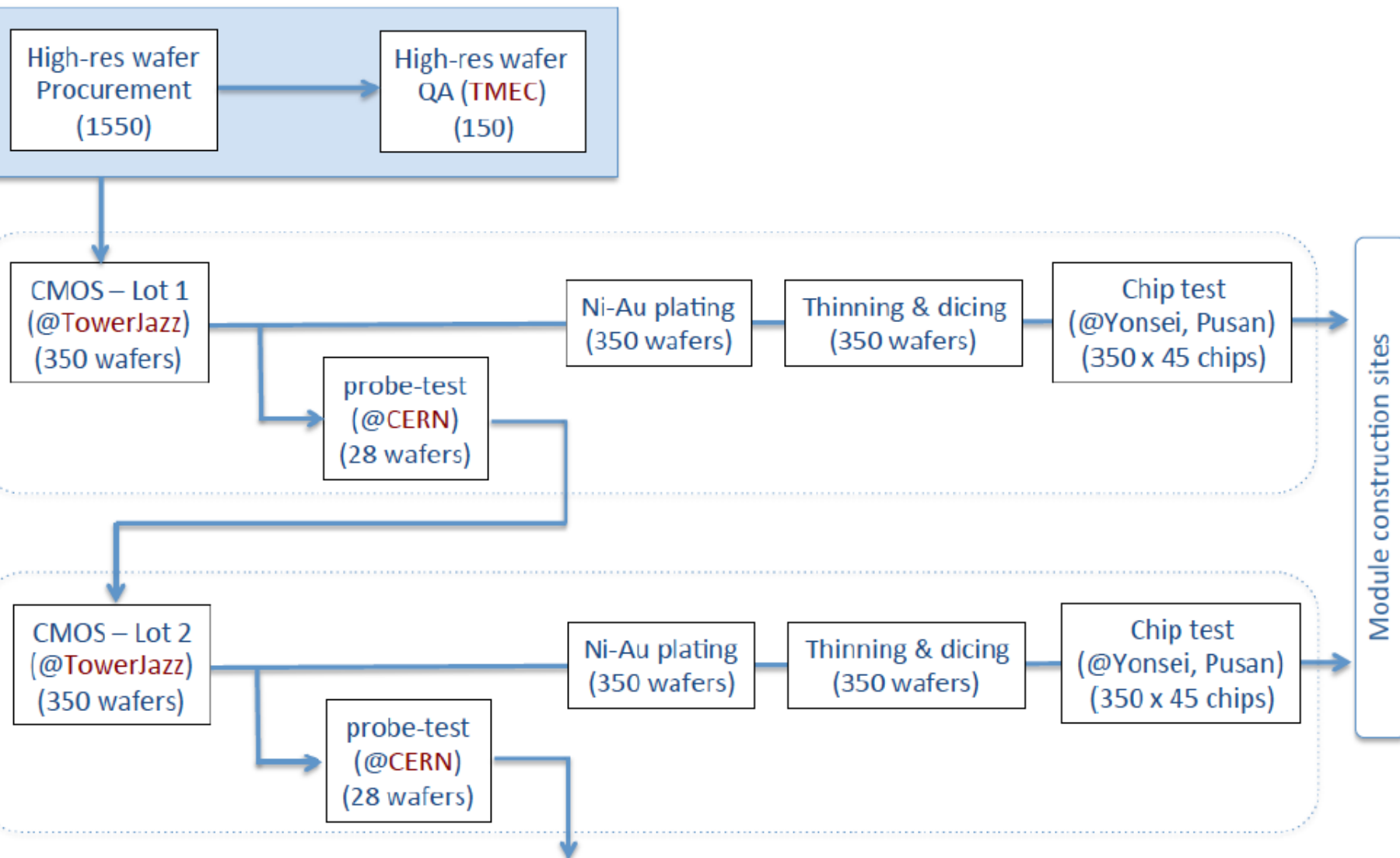
Cost breakdown

A Large Ion Collider Experiment

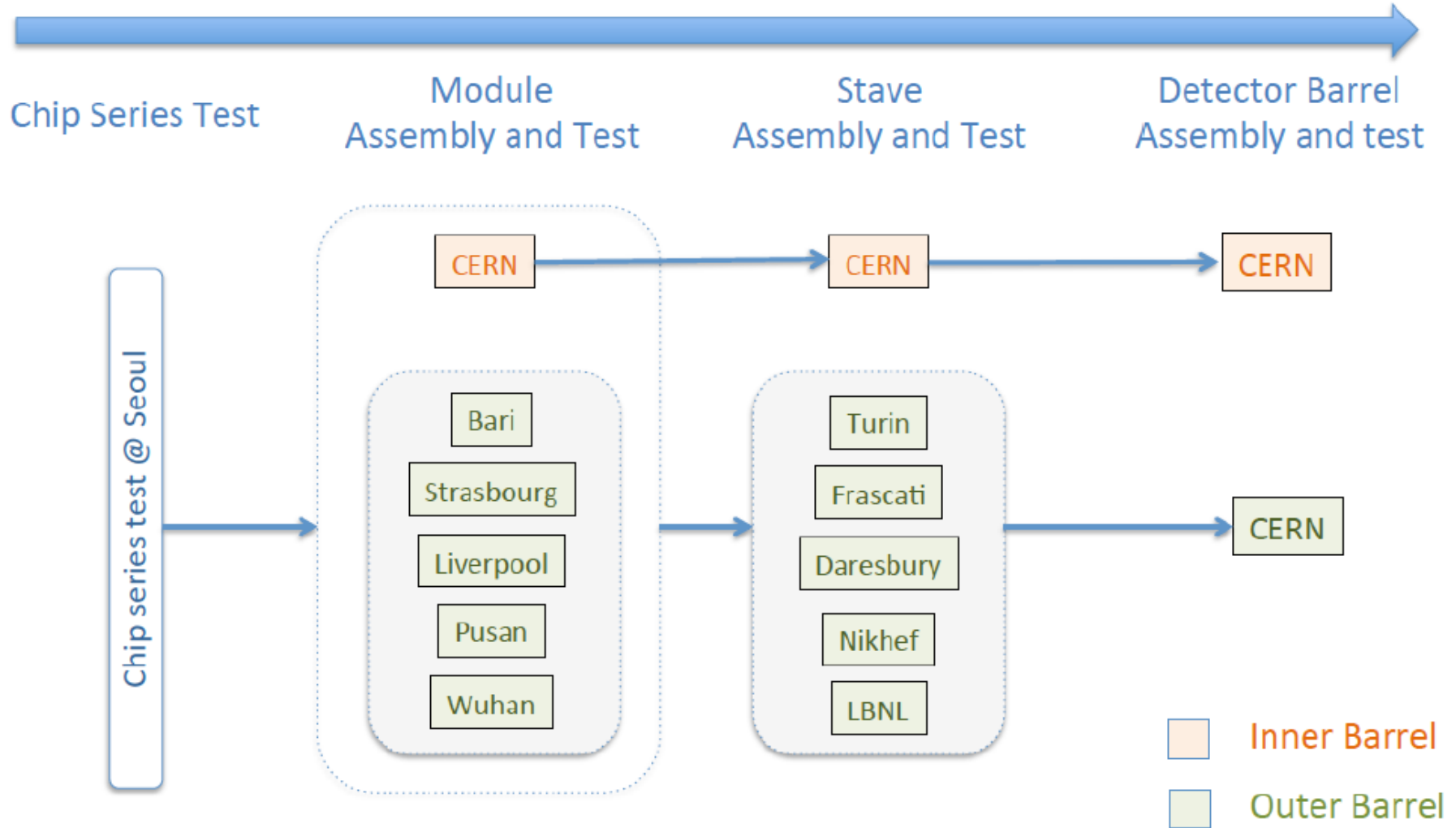


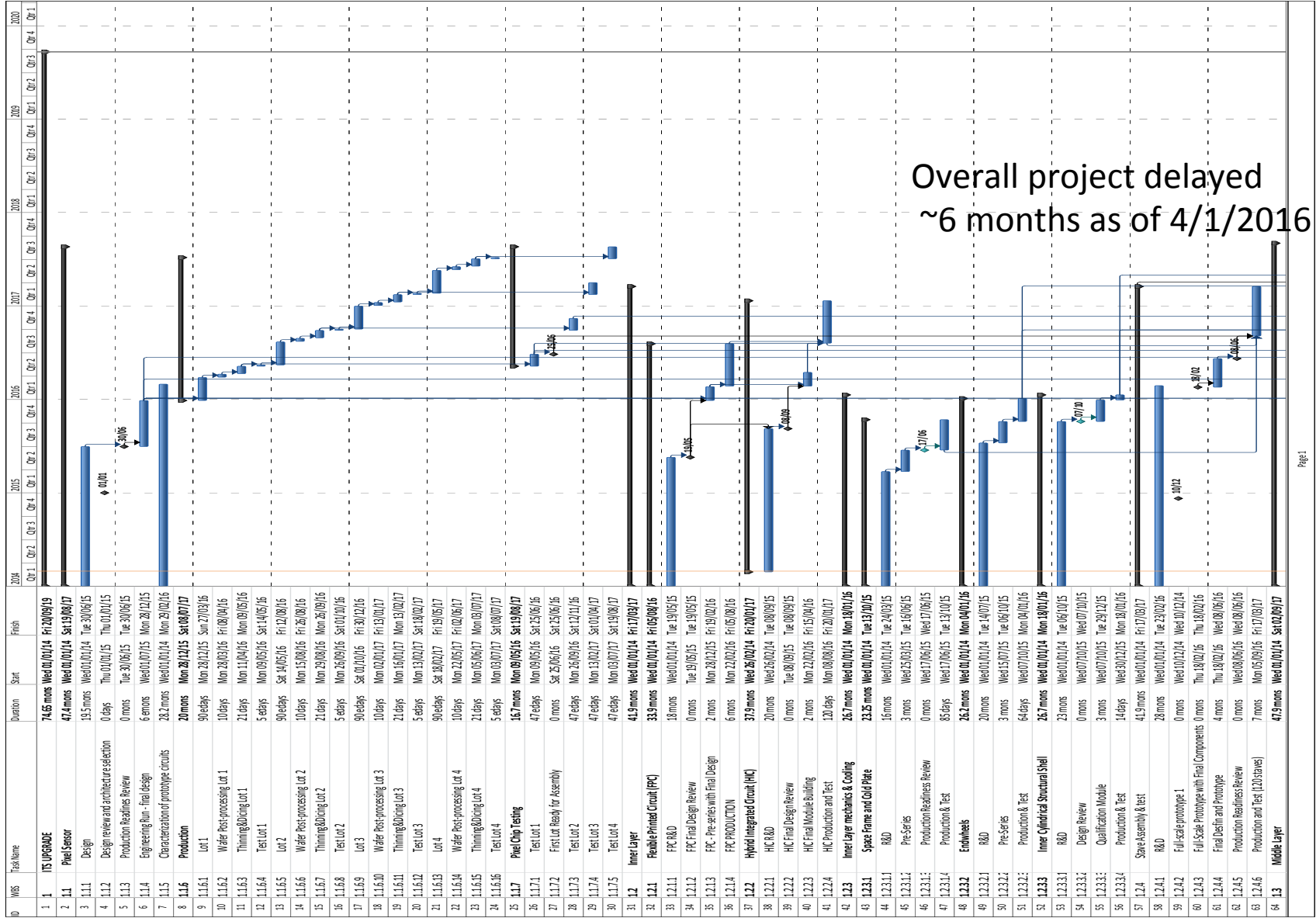
Activity	Material Costs	Manpower Costs	TOTAL COST / ITEM
9 Readout Electronics	715	50	765
9.1 Data e-Links	82	50	132
9.2 Patch-panels	20		20
9.3 Readout Unit	469		469
9.4 Optical Links	144		144
10 Power distribution	1149	50	1199
10.1 Power Supplies	750		750
10.2 Power Distribution	242	50	292
10.3 Power Regulation	157		157
11. DCS	150		150
12. Cooling	620	0	620
12.1 Water Cooling Plant	470		470
12.2 Ventilation Humidity Plant	150		150
GRAND TOTAL	9947	3693	13640

Pixel chip production flow chart

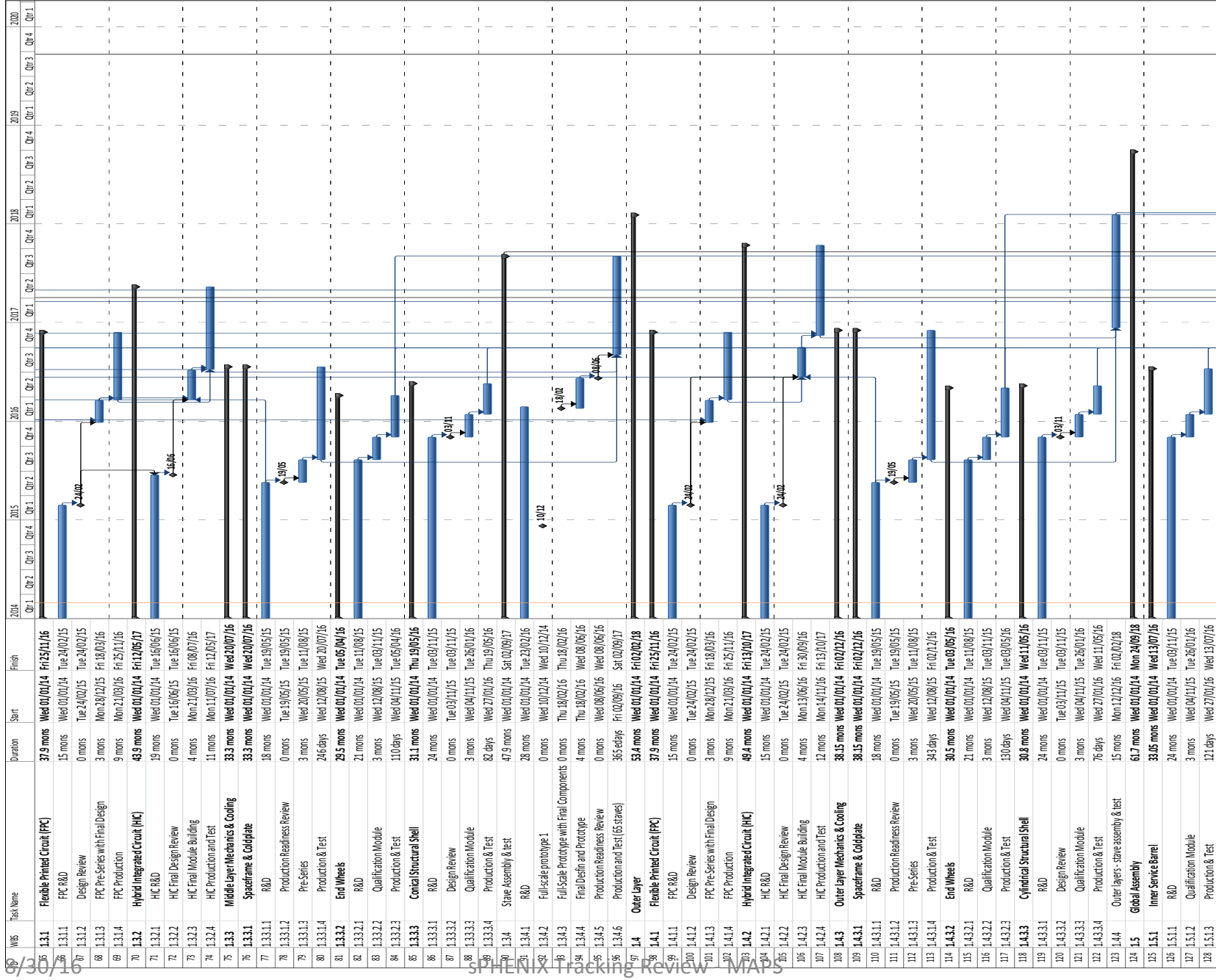


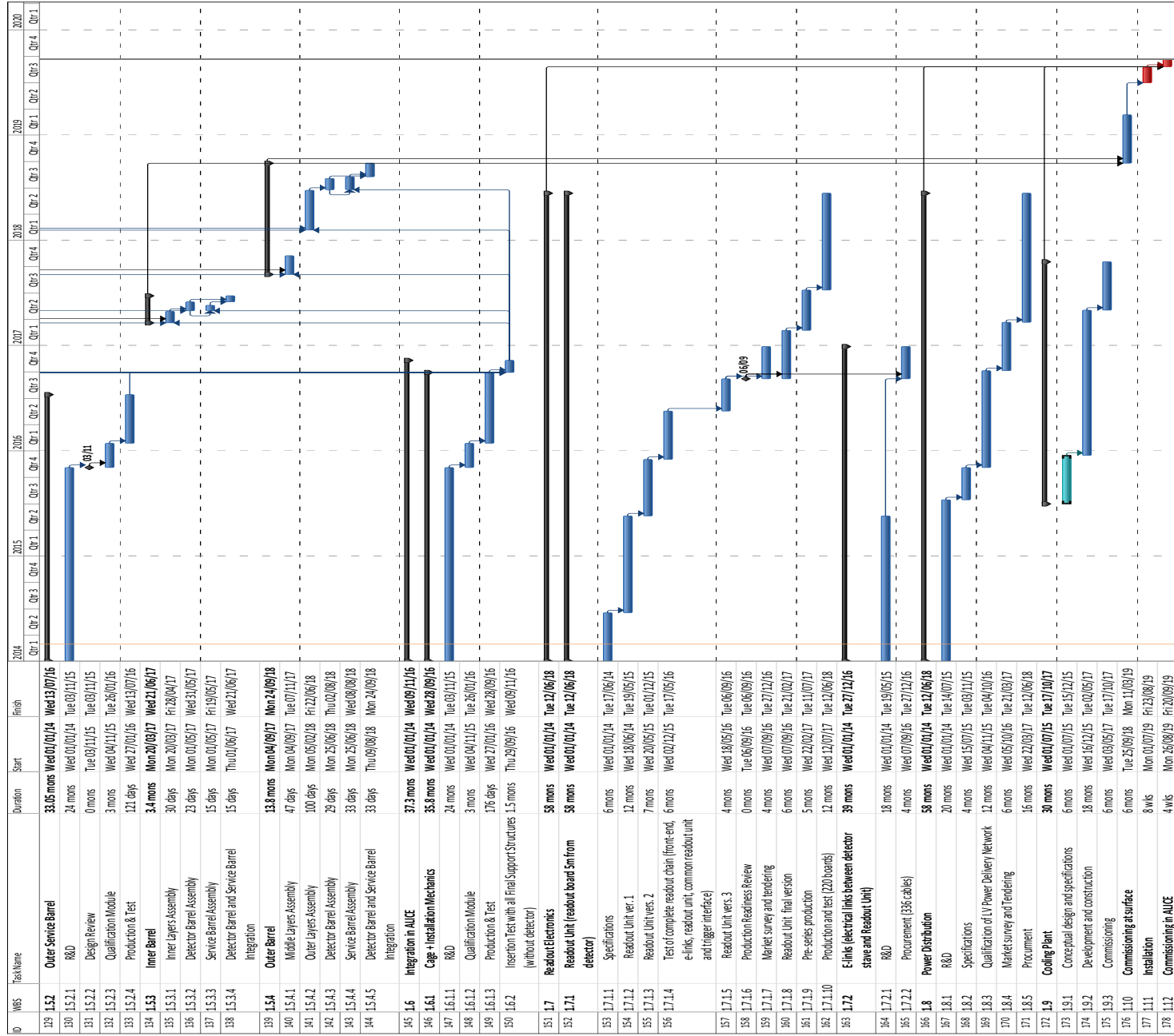
Module and Stave production flow chart





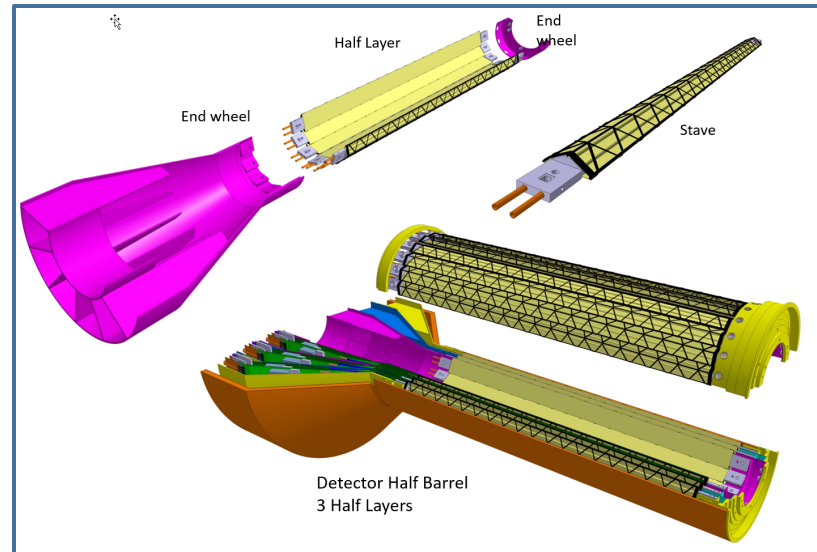
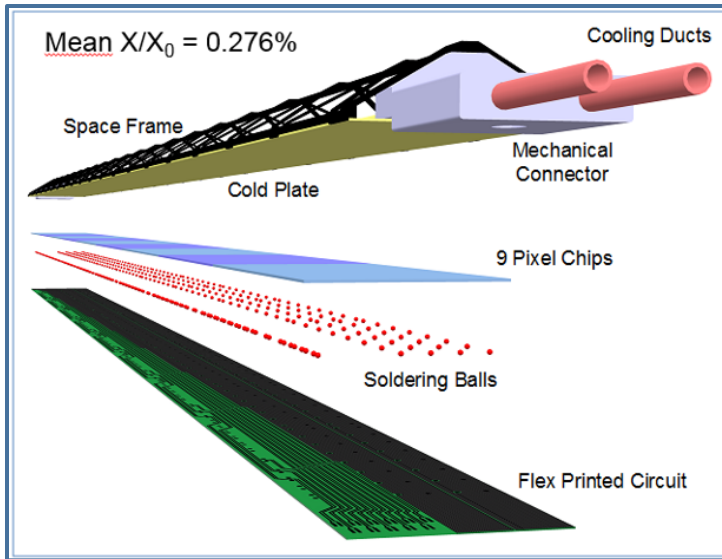
6/30/16







ITS Inner Layers vs PXL/STAR HFT



48 inner staves

Readout for: ➡

- 432 Sensors
- 226 M pixels
- 0.19 m² of silicon

Very comparable to PXL

STAR/HFT PXL Cost and schedule

Taken at CD-3

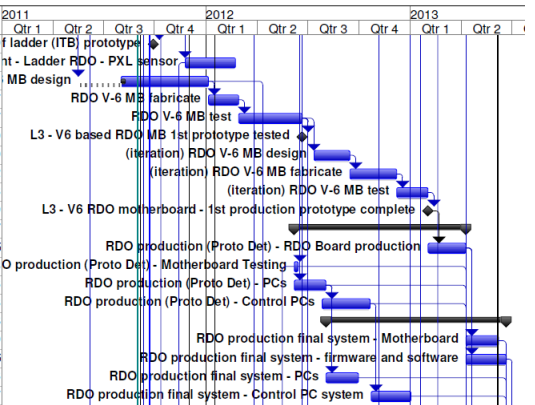
WBS	Task Name	Cost (\$K)
1.2	Pixel Detector (PXL)	4,993
1.2.1	Pixel Mechanics	1,210
1.2.2	Pixel Electronics	3,043
1.2.3	Detector Assembly	225
1.2.4	Infrastructure	515

- The cost for WBS 1.2.2.6 Readout Electronics is \$800k
- Production RDO boards are ~\$4.9k/board in quantities of 50.
- Most of the firmware and software was done by non-(project)costed people
- Full cost book to show detailed cost is available (distributed with slides in separate file).

PXL Cost and schedule

Taken at CD-3

ID	WBS	Task Name	% Complete	Duration	Start	Finish	Free Slack	Estimate Basis	Cost	2011	2012				2013				
										Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2
223	1.2.2.6.1.5	L3 - Full RDO of ladder (ITB) prototype	0%	0 days	6/28/11	6/28/11	972.75 days		\$0.00										
224	1.2.2.6.1.6	RDO Development - Ladder RDO - PXL sensor	0%	63 days	8/25/11	11/22/11	91 days	EJ	\$108,364.61										
225	1.2.2.6.1.7	RDO V-6 MB design	5%	109.58 days	2/15/11	10/5/11	0 days	EJ	\$64,399.01										
226	1.2.2.6.1.8	RDO V-6 MB fabricate	0%	36 days	10/5/11	11/28/11	0 days	EJ	\$77,966.47										
227	1.2.2.6.1.9	RDO V-6 MB test	0%	75 days	11/28/11	3/21/12	0 days	EJ	\$26,332.27										
228	1.2.2.6.1.10	L3 - V6 based RDO MB 1st prototype tested	0%	0 days	3/21/12	3/21/12	793.17 days		\$0.00										
229	1.2.2.6.1.11	(iteration) RDO V-6 MB design	0%	45 days	4/11/12	6/14/12	0 days	EJ	\$8,347.09										
230	1.2.2.6.1.12	(iteration) RDO V-6 MB fabricate	0%	58.33 days	6/14/12	9/6/12	0 days	EJ	\$45,545.62										
231	1.2.2.6.1.13	(iteration) RDO V-6 MB test	0%	40 days	9/6/12	11/1/12	0 days	EJ	\$17,249.58										
232	1.2.2.6.1.14	L3 - V6 RDO motherboard - 1st production prototype complete	0%	0 days	11/1/12	11/1/12	0 days		\$0.00										
233	1.2.2.6.2	RDO production (Proto Det)	0%	207.91 days	3/7/12	1/8/13	184 days		\$160,776.47										
234	1.2.2.6.2.1	RDO production (Proto Det) - RDO Board production	0%	39 days	11/1/12	1/8/13	0 days	EJ	\$112,572.15										
235	1.2.2.6.2.2	RDO production (Proto Det) - Motherboard Testing	0%	5 days	3/7/12	3/13/12	0 days	EJ	\$1,206.43										
236	1.2.2.6.2.3	RDO production (Proto Det) - PCs	0%	41 days	3/7/12	5/2/12	0 days	EJ	\$33,864.26										
237	1.2.2.6.2.4	RDO production (Proto Det) - Control PCs	0%	60 days	4/26/12	7/20/12	0 days	EJ	\$13,133.63										
238	1.2.2.6.3	RDO production final system	0%	216.91 days	5/3/12	3/21/13	72.09 days		\$155,180.28										
239	1.2.2.6.3.1	RDO production final system - Motherboard	0%	40 days	1/8/13	3/7/13	10 days	EJ	\$96,354.79										
240	1.2.2.6.3.2	RDO production final system - firmware and software	0%	50 days	1/8/13	3/21/13	0 days	EJ	\$11,822.66										
241	1.2.2.6.3.3	RDO production final system - PCs	0%	41 days	5/3/12	6/29/12	175.91 days	EJ	\$33,864.26										
242	1.2.2.6.3.4	RDO production final system - Control PC system	0%	50 days	7/23/12	10/1/12	111.91 days	EJ	\$13,138.57										



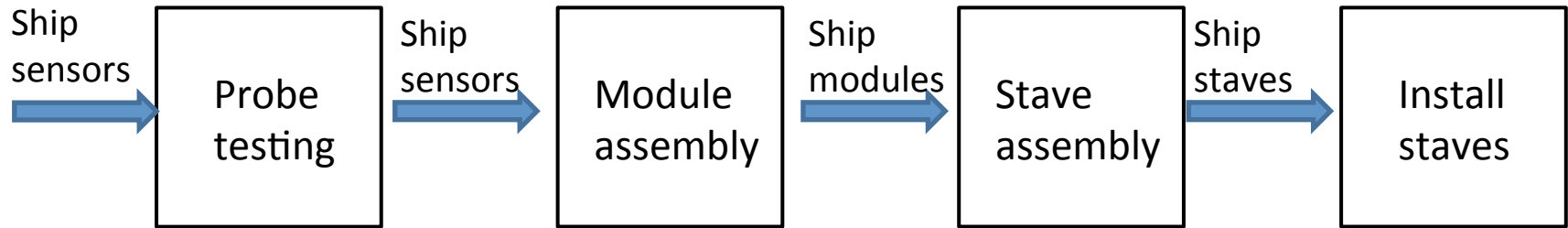
- 22 months - From initial RDO board design to delivery of all production RDO boards.
- We co-developed the earlier generations of sensors with the earlier generations of RDO so the firmware and software modules are often common to generations.
- Contributed resources are not counted in the project schedule document (firmware and software).

PXL RDO lessons learned

- Co-development of sensors and RDO was very useful. The architecture and code base is well tested and vetted with the sensors over generations and less likely to contain surprises.
- The production RDO system was designed to be the base for all testing. Beam tests, probe testing and other production testing. This unified our code base and simplified our hardware needs.
- Close attention should be paid to the interfaces and architecture that you are interfacing to. Allow extra time to find incompatibilities.
- A significant system test (at least a few chains) with beam and interfaced to the rest of the full DAQ, slow controls, etc. is highly desirable to uncover system level problems.
- The cost drivers for us were multiple design iterations of the production RDO boards, the interlock systems, the software and scripts for the interface to the STAR run and experiment control systems.
- Build in flexibility that will allow you to address unforeseen problems. Our LU damage problem was solved with the current limiting threshold and remote voltage adjustment capabilities built into the system.

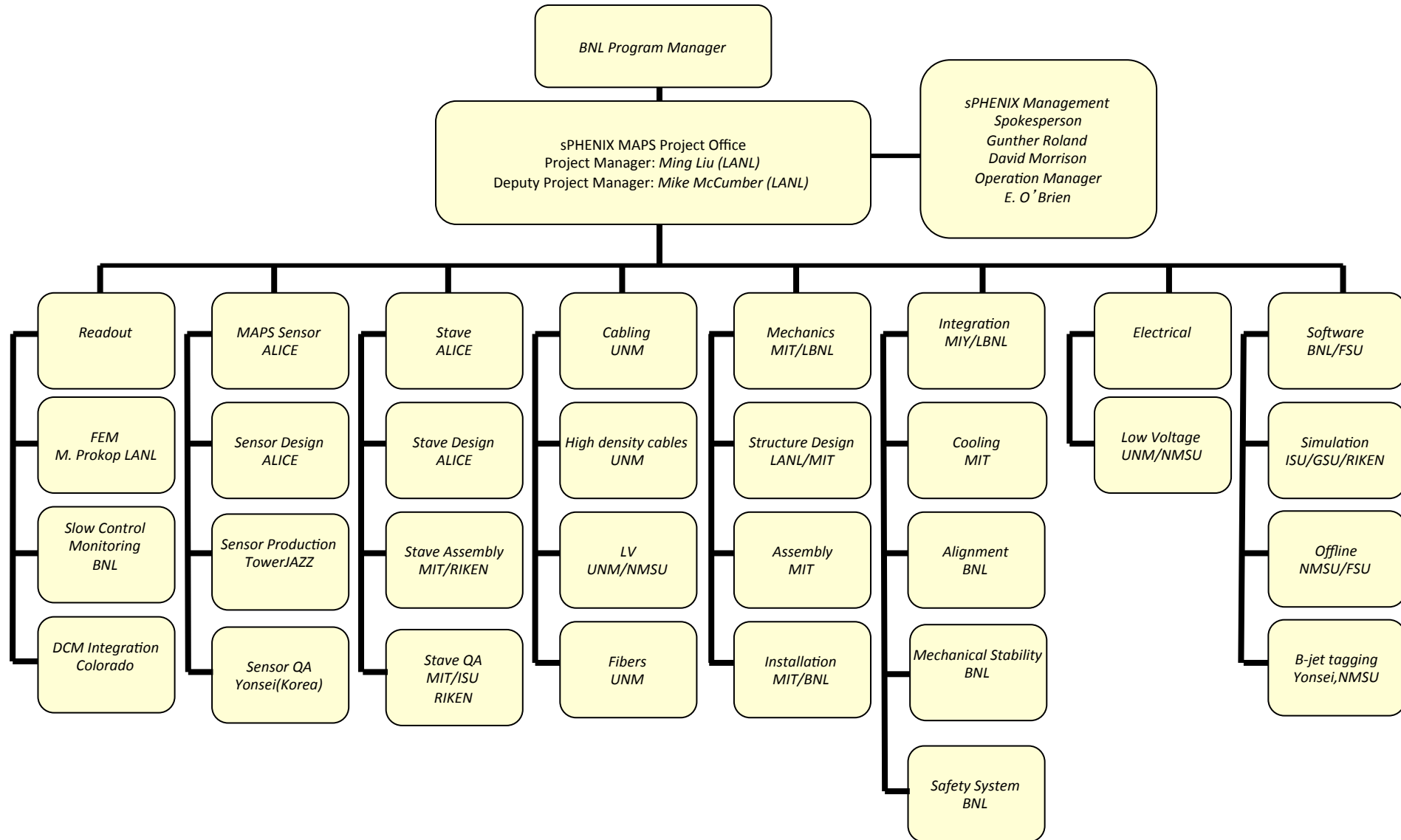
Workflow Overview

Leo's talk



- This is a draft overview of the workflow for building middle and outer layer staves.
- For this draft, we assume wire bonding for the interconnection technology.
- For this draft, we assume the tabbed version of the FPC.
- We are specifying a baseline workflow and will update as the sequences become more developed.
- Not all processes are fully developed.
- In the shipping stages, the barcode information for each item is stored in the database.

Organization Chart



Forming the Collaboration

- **On board:**
LANL, MIT, UNM, RIKEN, NMSU, BNL, Colorado, ISU, GSU, UT-Austin, UIC
- **Potential:**
LBNL, UCR, UC Davis, UCLA, Korean Institutes
- **Consulting:**
ALICE/CERN, Yonsei/Korea, CCNU/China

Resources I

- 1. LANL:
 - Supported by LDRD (FY17-19), will develop a 4-stave MAPS prototype to fully test the readout chain from MAPS to sPHENIX DAQ, and also initial mechanical design.
 - Provide electronics and mechanical engineering support through LDRD at least.
- 2. MIT:
 - Both HI and ME groups are joining the MAPS efforts, strong physics and engineering capabilities (Bates Center); extensive experience on technical integration and cooling system, worked on STAR HFT in collaboration with LBNL.
 - already have many students and postdocs working at CERN, could help on MAPS stave assembly and testing at CERN;
 - Could lead the stave assembly and testing at CERN and BNL, cooling and mechanical integration effort
- 3. LBNL:
 - Extensive experience in mechanical carbon structure and MAPS readout electronics, worked on PHENIX/ FVTX carbon frame supporting structure, already have test stand developed for the on-going ALICE MAPS upgrade project, will make a decision soon on joining the sPHENIX project.
 - Could lead the mechanical carbon support structure, assembly and testing of staves etc
- 4. BNL:
 - Strong technical capabilities in mechanical structure and DAQ, computing, slow control, safety and tech support, could lead the MAPS “Services” tasks;

Resources II

- 5. Univ. of Colorado
- Extensive experience with DAQ electronics, DCM-II and slow controls, close to LANL for collaborative work, excellent physics and simulation capabilities
- Could lead the DAQ DCM-II integration effort and simulation work
- 6. ISU
- Plan to add one postdoc to work on various MAPS related tasks and simulations, have several students
- Could take a major role on simulation effort, and testing MAPS
- 7. FSU
- Could continue to lead the tracking software effort, one graduate student
- 8. UNM
- Extensive experience through PHENIX Muon Tracker and FVTX projects on cabling, LV distribution and high density cables etc.
- Could lead effort on LV and cabling, design, testing and integration

Resources III

- 9. NMSU
 - Extensive experience with software and simulations, LV/HV control system etc.
 - Could play a major role on simulations, heavy-flavor tagging and physics analysis, provide manpower for testing and assembly work
- 10. GSU
 - Strong physics interest in heavy flavor, could play a major role on simulations and analysis, capable to develop small electronics control system
- 11. UCLA
 - Interested in MAPS hardware and heavy flavor physics, could play a major role on MAPS prototype R&D work and simulations, will send one student to work on LANL's LDRD project
- 12. UCR/UCDavis
 - Interested in MAPS project, heavy flavor physics, have local "very cost effective" machine and electronics shop to fabricate small structures and devices
- 13. Yonsei/Korea
 - Leading ALICE MAPS QA, could contribute to the production QA of MAPS chips, simulations and analysis
- 14. RIKEN/RBRC
 - Interested in MAPS project, from simulation to stave assembly and testing.

Project Input to sPHENIX Descoping/Cost Reduction Exercise

Scenario A	Δ	FY16 M\$	Scenario B	Δ
two-layer MAPS inner barrel	+3.0	one-layer MAPS inner barrel	+2.1	
no reuse of VTX	-0.2	no reuse of VTX	-0.2	
reduce TPC readout	-0.5	reduce TPC readout	-0.5	
reduce EMCal segmentation	-1.8	reduce EMCal segmentation	-1.8	
reduce EMCal η acceptance	-2.0	further reduce EMCal η acceptance	-2.2	
reduce DAQ refresh	-0.5	reduce DAQ refresh	-0.5	
reuse beam-beam trigger counter	-0.5	reuse beam-beam trigger counter	-0.5	
Total	-2.5		Total	-3.6

Specifically for Scenario B in the attached document there are 4 main areas of cost reduction:

1. Reduce TPC readout channels from 200k to 100k - \$500k
2. Reduce EMCal through 4 to1 ganging of tower output -\$1800k
3. Reduce EMCal eta coverage to $|\eta| < 0.7$ -\$2200k
4. Reduce DAQ/Trigger hardware -\$500k

Presume success in \$500k savings by obtaining a Trigger detector through an international collaborator or re-use of existing device

Presume the \$200k saved by not building VTX external support structure is in the MAPs cost estimate(?)

Could the appropriate L2 and L3 managers analyze the proposed cost savings and answer the following questions for each of the 4 items:

Answer by this Monday Jun 20

- Based on your best information are the cost savings reasonable?
- What is the schedule impact of the cut? It can be positive or negative.
- What if any additional technical risk will result from these cuts?

Specifically for the DAQ/Trigger, excluding the cut Trigger Device, the budget is cut from \$1.2M to \$0.7M.

Could Martin, Eric and Chi answer what would be purchased for \$0.7M and what would we have to forego?

Status of sPHENIX Project Preparation

- Defined the subsystem Project scope
- Defined WBS categories (Det:Design, Prototyping, Production, Elec:Design, Prototyping, Production)
- Defined Project approach
 - Software choices: MS-Project for CD-1, Primavera for CD-2/3
 - Use standard CD-1, CD-2/3 approval dates for project planning purposes
 - No final design until CD-1 approval. No production start until CD-3. **All R&D MUST be done prior to CD-3.**
 - Set number of scheduled reviews (preproduction , safety, post prototype...), include 3 rounds of prototyping in most cases.
- Assign resources and durations to all tasks
 - All L3 manager 20% time just to manage. All L2 managers 50% time.
 - All procurements should have small amount of resources defined to follow orders.
- Procurement tasks
 - Orders < \$100k 1 month to place order
 - Orders < \$1M 3 month to place orders
 - Orders > \$1M 6 months to place orders
- All tasks are linked with predecessors and successors
- Material costs are assigned where appropriate
- Define labor bands are associated with the labor resources
- Analyze labor and budget profiles.

sPHENIX Schedule Summary

Project Schedule and Budget incorporating Review committee recommendations:

CD-0 **Apr 2016 (keep for now but it will slip)**

DOE approval to decommission PHENIX Apr 2016

Decommissioning starts immediately at the end of Run-16, mid Jun 2016

CD-1/CD-3a **Nov 2017**

CD-3b **Jul 2018**

Tracker fully assembled and tested. Ready for installation in 1008 Jan 2021.

sPHENIX installed commissioned and ready for beam Jun 2021.

First RHIC Beam for sPHENIX Jan 2022

CD-4 **Jan 2023**

The critical path for the project is through the Outer HCal. The schedule has 8.5 months of float to 1st beam Jan 2022.

Responsibilities (FVTX)

The sensors will be a joint responsibility between US and the Prague group from the Czech Republic, with the Prague group doing the bulk of the R&D. A collaboration has been formed with the FNAL Engineering Dept., headed by Ray Yarema, for development of the FPHX chip.

The FNAL group has modified an existing operational FPIX2 chip to our specifications and will produce and test the new FPHX chips. Los Alamos National Laboratory (LANL) will oversee this effort.

The HDI will be a joint US institutional responsibility with University of New Mexico (UNM) leading the effort.

The sensor wedge assemblies are the responsibility of Columbia University. The cooling backplane will be purchased through an engineering firm, HYTEC.